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Computer-Based Instruments

NI 5102 User Manual

High-Speed Digitizer

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Worldwide Technical Support and Product Information

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Compliance

FCC/Canada Radio Frequency Interference Compliance*

Determining FCC Class

The Federal Communications Commission (FCC) has rules to protect wireless communications from interference. The FCC places digital electronics into two classes. These classes are known as Class A (for use in industrial-commercial locations only) or Class B (for use in residential or commercial locations). Depending on where it is operated, this product could be subject to restrictions in the FCC rules. (In Canada, the Department of Communications (DOC), of Industry Canada, regulates wireless interference in much the same way.)

Digital electronics emit weak signals during normal operation that can affect radio, television, or other wireless products. By examining the product you purchased, you can determine the FCC Class and therefore which of the two FCC/DOC Warnings apply in the following sections. (Some products may not be labeled at all for FCC; if so, the reader should then assume these are Class A devices.)

FCC Class A products only display a simple warning statement of one paragraph in length regarding interference and undesired operation. Most of our products are FCC Class A. The FCC rules have restrictions regarding the locations where FCC Class A products can be operated.

FCC Class B products display either a FCC ID code, starting with the letters **EXN**, or the FCC Class B compliance mark that appears as shown here on the right.



Consult the FCC web site `http://www.fcc.gov` for more information.

FCC/DOC Warnings

This equipment generates and uses radio frequency energy and, if not installed and used in strict accordance with the instructions in this manual and the CE Mark Declaration of Conformity**, may cause interference to radio and television reception. Classification requirements are the same for the Federal Communications Commission (FCC) and the Canadian Department of Communications (DOC).

Changes or modifications not expressly approved by National Instruments could void the user's authority to operate the equipment under the FCC Rules.

Class A

Federal Communications Commission

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Canadian Department of Communications

This Class A digital apparatus meets all requirements of the Canadian Interference-Causing Equipment Regulations.

Cet appareil numérique de la classe A respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

Class B

Federal Communications Commission

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Canadian Department of Communications

This Class B digital apparatus meets all requirements of the Canadian Interference-Causing Equipment Regulations.

Cet appareil numérique de la classe B respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

Compliance to EU Directives

Readers in the European Union (EU) must refer to the Manufacturer's Declaration of Conformity (DoC) for information** pertaining to the CE Mark compliance scheme. The Manufacturer includes a DoC for most every hardware product except for those bought for OEMs, if also available from an original manufacturer that also markets in the EU, or where compliance is not required as for electrically benign apparatus or cables.

To obtain the DoC for this product, click **Declaration of Conformity** at `ni.com/hardref.nsf/`. This website lists the DoCs by product family. Select the appropriate product family, followed by your product, and a link to the DoC appears in Adobe Acrobat format. Click the Acrobat icon to download or read the DoC.

* Certain exemptions may apply in the USA, see FCC Rules §15.103 **Exempted devices**, and §15.105(c). Also available in sections of CFR 47.

** The CE Mark Declaration of Conformity will contain important supplementary information and instructions for the user or installer.

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About This Manual

The NI 5102 is an analog input device available in PCI, PXI, ISA, PCMCIA, and USB form factors. This manual describes the installation and operation of these digitizers.

Conventions Used in This Manual

The following conventions are used in this manual:

<>	Angle brackets that contain numbers separated by an ellipsis represent a range of values associated with a bit or signal name—for example, DBIO<3..0>.
»	The » symbol leads you through nested menu items and dialog box options to a final action. The sequence **File»Page Setup»Options** directs you to pull down the **File** menu, select the **Page Setup** item, and select **Options** from the last dialog box.
♦	The ♦ symbol indicates that the following text applies only to a specific product, a specific operating system, or a specific software version.
	This icon denotes a note, which alerts you to important information.
	This icon denotes a caution, which advises you of precautions to take to avoid injury, data loss, or a system crash.
bold	Bold text denotes items that you must select or click on in the software, such as menu items and dialog box options. Bold text also denotes parameter names.
digitizer	Refers to an NI 5102.
italic	Italic text denotes variables, emphasis, a cross reference, or an introduction to a key concept. This font also denotes text that is a placeholder for a word or value that you must supply.
`monospace`	Text in this font denotes text or characters that you should enter from the keyboard, sections of code, programming examples, and syntax examples. This font is also used for the proper names of disk drives, paths, directories, programs, subprograms, subroutines, device names, functions, operations, variables, filenames and extensions, and code excerpts.

NI 5102	NI 5102 is a generic term that denotes one or more of the NI 5102 (PCI), NI 5102 (PXI), NI 5102 (ISA), NI 5102 (PCMCIA), and NI 5102 (USB) devices.
NI 5102 (ISA)	Refers to the NI 5102 for ISA bus.
NI 5102 (PCI)	Refers to the NI 5102 for PCI bus.
NI 5102 (PCMCIA)	Refers to the NI 5102 for computers with a Type II PCMCIA slot.
NI 5102 (PXI)	Refers to the NI 5102 for PXI bus.
NI 5102 (USB)	Refers to NI 5102 for computers that are USB compatible.
NI-DAQ	NI-DAQ refers to the NI-DAQ software for PC compatibles unless otherwise noted.
Plug and Play	Plug and Play refers to a device that is fully compatible with the industry standard Plug and Play specification. Plug and Play systems automatically arbitrate and assign system resources, freeing the user from manually configuring jumpers or switches to configure settings such as the product base address and interrupt level.

Related Documentation

The *NI 5102 User Manual* is one piece of documentation for your measurement system. Depending on the hardware and software in your system, the following documents may also be helpful:

- *Where to Start wih Your NI Digitizer*
- *NI-SCOPE Quick Reference Guide*
- *NI-SCOPE Software User Manual*
- PXI Systems Alliance *PXI Specification*, revision 2.0

1

Introduction

This chapter describes the National Instruments (NI) 5102 and lists additional equipment.

About Your NI 5102

Thank you for your purchase of an NI 5102. The NI 5102 family consists of five different devices tailored to your choice of bus: the PCI, the PXI, the ISA, the PCMCIA, and the universal serial bus (USB). Your NI 5102 has the following features:

- Two 8-bit resolution analog input channels
- Real-time sampling rate of 20 MS/s to 1 kS/s; 1 GS/s random interleaved sampling (RIS)
- 15 MHz analog input bandwidth
- Analog trigger channel with software-selectable level, slope, and hysteresis
- Two digital triggers
- Software-selectable AC/DC coupling
- 663,000-sample onboard memory
- Real-Time System Integration (RTSI) triggers (PCI, PXI, and ISA form factors only)

All NI 5102 devices follow industry-standard Plug and Play specifications on all platforms and offer seamless integration with compliant systems. If your application requires more than two channels for data acquisition, you can synchronize multiple devices on all platforms using RTSI bus triggers, on devices that use the RTSI bus, or the PFI digital triggers on the I/O connector. The NI 5102 (PXI) uses the PXI trigger bus for multiboard synchronization. Unless otherwise noted, any discussion of the RTSI trigger bus is also applicable to the PXI trigger bus for the NI 5102 (PXI) in this manual.

To improve timing resolution for repetitive signals, you can use random interleaved sampling (RIS) on your NI 5102. This method of sampling allows you to view pretrigger data and achieve an effective sampling rate as high as 1 GS/s, 50 times the real-time sampling rate of the device.

Detailed specifications of the NI 5102 devices are in Appendix A, *Specifications*.

Acquiring Data with Your NI 5102

You can acquire data either programmatically by writing an application for your NI 5102 or interactively with the Scope Soft Front Panel. There are several options to choose from when programming your NI 5102. If you are using the NI 5102 as a general-purpose digitizer, you can use the Scope Soft Front Panel to make measurements interactively without writing code.

If you want to integrate the NI 5102 in your test and measurement application, you can program the device using LabVIEW, LabWindows/CVI, C/C++, or Measure. Figure 1-1 illustrates this relationship. If you are controlling your digitizers programatically you have two programming choices—the NI-SCOPE driver or the NI-DAQ API.

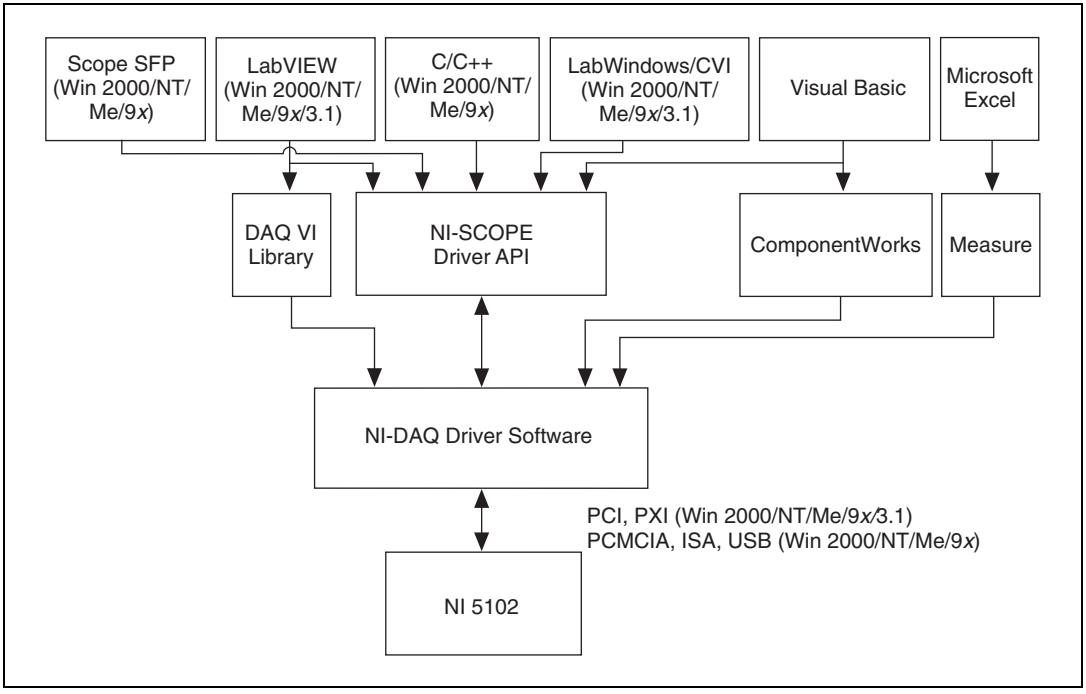


Figure 1-1. The Relationship Between the Programming Environment, NI-DAQ, and Your Hardware

Interactively Controlling your NI 5102 with the Scope Soft Front Panel

The Scope Soft Front Panel allows you to interactively control your NI 5102 as you would a desktop oscilloscope. To launch the Scope Soft Front Panel, select **Start»Programs»National Instruments» NI-SCOPE»NI-Scope Soft Front Panel**. Refer to the *Scope Soft Front Panel Help* file for instructions on configuring and running the Scope Soft Front Panel for your specific application.

Note Press F1with the Soft Front Panel running to access the *Scope Soft Front Panel Help*.

NI-SCOPE Driver

The NI-SCOPE driver is the preferred choice to program your NI 5102. It provides flexibility and programmability in a standard full-featured instrument-driver format which lets you avoid low-level software calls and which works with LabVIEW, LabWindows/CVI, and conventional languages such as C/C++ and Visual Basic.

To help you get started, NI-SCOPE comes with examples you can use or modify.

You can find examples for these different ADEs:

- LabVIEW— Go to `Program Files\National Instruments\LabVIEW\Examples\Instr\niscopeExamples\`
- LabWindows/CVI, C, and Visual Basic with Windows 9*x*—Go to `vxipnp\win95\Niscope\Examples\c\`
- LabWindows/CVI, C, and Visual Basic with Windows 2000/NT—Go to `vxipnp\winnt\Niscope\Examples\`

NI-DAQ API

The NI-DAQ driver software is automatically installed with NI-SCOPE, and contains all of the device-specific code that is required to program the NI 5102 using any hardware bus. The NI-DAQ API allows you to program your NI 5102 in LabVIEW using calls that are supported on other NI-DAQ devices. The DAQ VI Library offers a collection of VIs that you can use to program your NI 5102 to function as a digitizer.

NI Application Software

LabVIEW and Measurement Studio are innovative program development software packages for data acquisition and control applications. Both packages include extensive libraries for data acquisition, instrument control, data analysis, and graphical data presentation. Both will greatly reduce the development time for your data acquisition and control application.

LabVIEW features interactive graphics, a state-of-the-art user interface, and a powerful graphical programming language. You can program the NI 5102 in LabVIEW through an instrument driver application programming interface (API) for quick application development, or use the LabVIEW Data Acquisition VI Library, a series of VIs for using LabVIEW with NI-DAQ hardware, for increased flexibility and control.

Note NI 5102 digitizers use only the easy I/O interface under data acquisition in LabWindows/CVI. The easy I/O interface provides limited functionality in CVI. To use the NI 5102 to its full capabilities, use the NI-SCOPE driver as shown in Figure 1-1.

Measurement Studio contains tools for data acquisition and device control built on NI-DAQ driver software. Measurement Studio provides a higher-level programming interface for building virtual instruments with Visual Basic, Visual C++, and LabWindows/CVI. With Measurement Studio, you can use all of the configuration tools, resource management utilities, and interactive control utilities included with NI-DAQ.

LabWindows/CVI features interactive graphics, a state-of-the-art user interface, and uses the ANSI standard C programming language. The LabWindows/CVI Data Acquisition Library, a series of functions for using LabWindows/CVI with NI-DAQ hardware, is included with the NI-DAQ software kit.

Measure is a data acquisition and device control add-in for Microsoft Excel. With Measure, you can acquire data directly from plug-in DAQ boards, GPIB tools, or serial (RS-232) devices. Measure has easy-to-use dialogs for configuring your measurements. Your data is placed directly into Excel worksheet cells, from which you can perform your analysis and report generation operations.

Using PXI with CompactPCI

- NI 5102 (PXI) Only

Using PXI-compatible products with standard CompactPCI products is an important feature provided by the *PXI Specification*, revision 1.0. If you use a PXI-compatible plug-in device in a standard CompactPCI chassis, you will be unable to use PXI-specific functions, but you can still use the basic plug-in device functions. For example, the PXI trigger bus on your NI 5102 (PXI) is available in a PXI chassis but not in a CompactPCI chassis.

The CompactPCI specification permits vendors to develop sub-buses that coexist with the basic PCI interface on the CompactPCI bus. Compatible operation is not guaranteed between CompactPCI devices with different sub-buses nor between CompactPCI devices with sub-buses and PXI. The standard implementation for CompactPCI does not include these sub-buses. Your NI 5102 (PXI) will work in any standard CompactPCI chassis.

PXI-specific features, RTSI bus trigger, RTSI Clock, and Serial Communication are implemented on the J2 connector of the CompactPCI bus. Table 1-1 lists the J2 pins used by your NI 5102 (PXI) digitizer, which is compatible with any CompactPCI chassis with a sub-bus that does not drive these lines. Even if the sub-bus is capable of driving these lines, the NI 5102 (PXI) is still compatible as long as those pins on the sub-bus are disabled by default and are never enabled. Damage can result if these lines are driven by the sub-bus.

Table 1-1. NI 5102 (PXI) J2 Pin Assignment

NI 5102 (PXI) Signal	PXI Pin Name	PXI J2 Pin Number
RTSI Trigger <0..5>	PXI Trigger <0..5>	B16, A16, A17, A18, B18, C18
RTSI Trigger 6	PXI Star	D17
RTSI Clock	PXI Trigger (7)	E16
Serial Communication	LBR (6, 7, 8, 9, 10, 11, 12)	EI5, A3, C3, D3, E3, A2, B2

Optional Equipment

NI offers a variety of products to use with your digitizer, including probes, cables, and other accessories, as follows:

- Cables for master/slave timing and triggering
- Cables for external triggering
- RTSI bus cables for NI 1502 (PCI, ISA)
- AUX Interface Cables for NI 5102 (PXI) only

For more specific information about these products, refer to the NI catalog or website, or call the office nearest you.

2

Installation and Configuration

This chapter describes how to unpack, install, and configure your NI 5102.

What You Need to Get Started

To set up and use your NI 5102, you will need the following:

- ❑ One of the following NI 5102 devices:
  - NI 5102 (PCI)
  - NI 5102 (PXI)
  - NI 5102 (ISA)
  - NI 5102 (PCMCIA)
  - NI 5102 (USB)
- ❑ NI-SCOPE Driver CD
- ❑ One of the following software packages and documentation:
  - LabVIEW
  - An application development environment (ADE) such as LabWindows/CVI, Visual C++, or Visual Basic. Alternatively, you may use the Scope Soft Front Panel to interactively control your NI 5102.
  - Measure for MS Excel
- ❑ Cables and accessories:
  - NI 5102 (PCI, PXI, ISA, PCMCIA, USB)

    Two SP200B 10X-1X selectable oscilloscope probes

    SMB100 cable and screwdriver for probe compensation
  - NI 5102 (PXI)

    AUX to BNC cable
  - NI 5102 (PCMCIA)

    PSH32-C5 I/O cable assembly

  – NI 5102 (USB)

    NI 5102 (USB) power supply

❑ Vinyl pouch for storing cables and accessories for the NI 5102 (PCMCIA) only

Unpacking

♦ NI 5102 (PCI, PXI, ISA)

Your device is shipped in an antistatic package to prevent electrostatic damage to the device. Electrostatic discharge can damage several components on the device. To avoid such damage in handling the device, take the following precautions:

- Ground yourself via a grounding strap or by holding a grounded object.
- Touch the antistatic package to a metal part of your computer chassis before removing the device from the package.
- Remove the device from the package and inspect the device for loose components or any other sign of damage. Notify NI if the device appears damaged in any way. Do *not* install a damaged device into your computer.
- *Never* touch the exposed pins of the connectors.

♦ NI 5102 (PCMCIA)

Your NI 5102 is shipped in an antistatic vinyl case; when you are not using the card, you should store it in this case. Because the device is enclosed in a fully shielded case, no additional electrostatic precautions are necessary. However, for your own safety and to protect the card, *never* attempt to touch the pins of the connectors.

♦ NI 5102 (USB)

Your device is shipped in a fully shielded case, and no electrostatic precautions are necessary. However, for your own safety and to protect your NI 5102 (USB), *never* attempt to touch the connector pins.

Installing the NI 5102

There are two main steps involved in installation:

1. Install the NI-SCOPE driver software. You use this driver to write programs to control your NI 5102 in different application development environments (ADEs). Installing NI-SCOPE also allows you to interactively control your NI 5102 with the Scope Soft Front Panel.
2. Install your NI 5102. For step-by-step instructions for installing NI-SCOPE and the NI 5102, see *Where to Start with Your NI Digitizer.*

- NI 5102 (PCI, ISA)

  For best noise performance, leave as much room as possible between your NI 5102 and other hardware.

- NI 5102 (PXI)

  The NI 5102 (PXI) has connections to several reserved lines on the CompactPCI J2 connector. Before installing a NI 5102 (PXI) in a CompactPCI system that uses J2 connector lines for purposes other than PXI, see the *Using PXI with CompactPCI* section of Chapter 1, *Introduction*, of this manual.

- NI 5102 (PCMCIA)

  For Windows 3.*x*, you must have Card and Socket Services 2.0 or later installed.

- NI 5102 (USB)

  With your PC running, power on your installed NI 5102 (USB). The PC automatically detects the device and the LED on the NI 5102 (USB) front panel will light.

  If the LED remains lit after the NI 5102 (USB) is powered on and connected to the host, it is functioning properly. If the LED is blinking or off, there may be a problem. Refer to Table 2-1 for the LED pattern descriptions. The LED blinks on and off for one second each as many times as necessary, then waits three seconds before repeating the cycle.

Table 2-1. NI 5102 (USB) LED Patterns

LED	NI 5102 (USB) State	Description
On	Configured State	Your NI 5102 (USB) is configured.
Off	Off or in the low-power, suspend mode	Your NI 5102 (USB) is turned off or in the low-power, suspend mode.
2 Blinks	Addressed state	This pattern is displayed if the host computer detects your NI 5102 (USB) but cannot configure it because NI-DAQ is not installed properly or because there are no system resources available. If the NI 5102 (USB) remains in this state, check your software installation.
4 Blinks	General error state	If this pattern is displayed, contact NI.

Hardware Configuration

The NI 5102 is a fully software-configurable, Plug and Play device. Hardware configuration information and resource requirements are stored in nonvolatile memory. The Plug and Play services query the device, read the information, and arbitrate resource allocation for items such as base address, interrupt level, and DMA channel. After assigning these resources, the operating system enables the device for operation.

3

Digitizer Basics

This chapter explains basic information about using digitizers, including important terminology and use of the probe.

Understanding Digitizers

To understand how digitizers work, you should be familiar with the Nyquist theorem and how it affects analog bandwidth and sample rate. You should also understand vertical sensitivity, analog-to-digital converter (ADC) resolution, record length, and triggering options.

Nyquist Theorem

The Nyquist theorem states that a signal must be sampled at least twice as fast as its bandwidth in order to accurately reconstruct the waveform; otherwise, the high-frequency content will *alias* at a frequency inside the spectrum of interest (passband). An alias is a false lower frequency component that appears in sampled data acquired at too low a sampling rate. Figure 3-1 shows a 5 MHz sine wave digitized by a 6 MS/s ADC. The dotted line indicates the aliased signal recorded by the ADC at that sample rate.

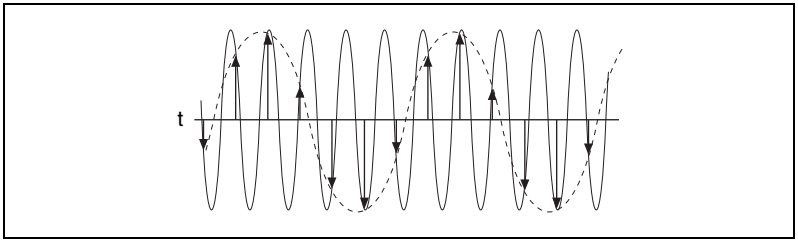


Figure 3-1. Aliased Sine Wave When Waveform is Under Sampled

The 5 MHz frequency aliases back in the passband, falsely appearing as if it were a 1 MHz sine wave. To prevent aliasing in the passband, a lowpass filter limits the frequency content of the input signal above the Nyquist rate.

Analog Bandwidth

Analog bandwidth describes the frequency range (in hertz) in which a signal can be digitized accurately. This limitation is determined by the inherent frequency response of the input path—from the tip of the probe to the input of the ADC—which causes loss of amplitude and phase information. *Analog bandwidth* is the frequency at which the measured amplitude is 3 dB below the actual amplitude of the signal. Figure 3-2 illustrates the effect of analog bandwidth on a high-frequency signal. The result is a loss of high-frequency components and amplitude in the original signal as the signal passes through the digitizer.

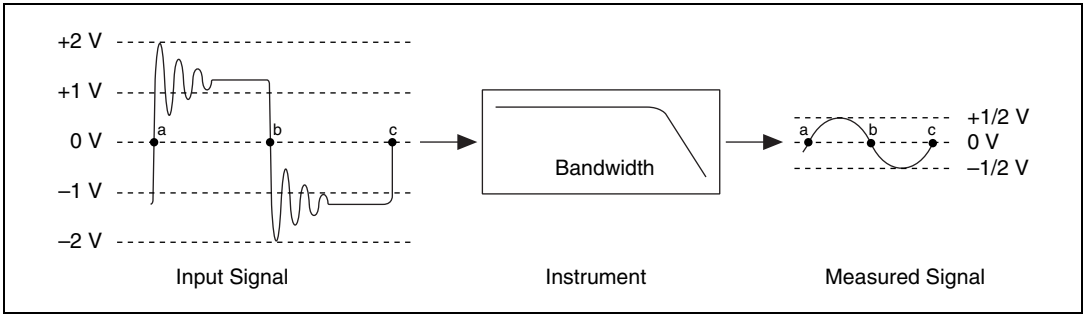


Figure 3-2. Analog Bandwidth

Sample Rate

Sample rate is the rate at which a signal is sampled and digitized by an ADC. According to the Nyquist theorem, a higher sample rate produces accurate measurement of higher frequency signals if the analog bandwidth is wide enough to let the signal to pass through without attenuation. A higher sample rate also captures more waveform details.

Figure 3-3 illustrates a 1 MHz sine wave sampled by a 2 MS/s ADC and a 20 MS/s ADC. The faster ADC digitizes 20 points per cycle of the input signal compared with 2 points per cycle with the slower ADC. In this example, the higher sample rate more accurately captures the waveform shape as well as frequency.

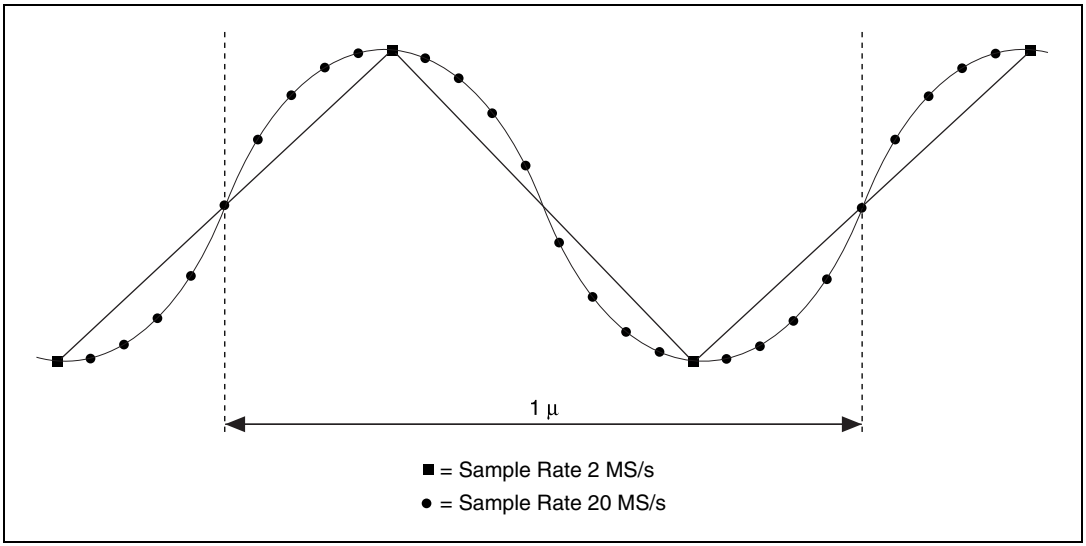


Figure 3-3. 1 MHz Sine Wave Sample

Vertical Sensitivity

Vertical sensitivity describes the smallest input voltage change the digitizer can capture. This limitation is because one distinct digital voltage encompasses a range of analog voltages. Therefore, it is possible that a minute change in voltage at the input is not noticeable at the output of the ADC. This parameter depends on the input range, gain of the input amplifier, and ADC resolution. It is specified in volts per least significant bit (V/LSB). Figure 3-4 shows the transfer function of a 3-bit ADC with a vertical range of 5 V having a vertical sensitivity of 5/8 V/LSB.

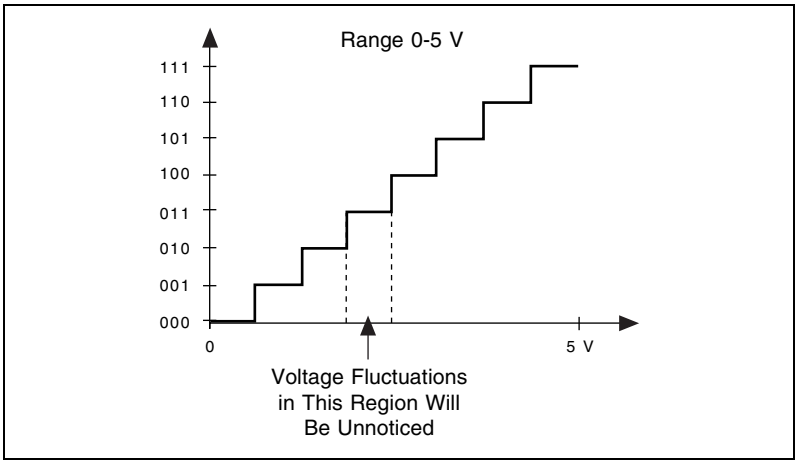


Figure 3-4. Transfer Function of a 3-Bit ADC

ADC Resolution

ADC resolution limits the accuracy of a measurement. The higher the resolution (number of bits), the more accurate the measurement. An 8-bit ADC divides the vertical range of the input amplifier into 256 discrete levels. With a vertical range of 10 V, the 8-bit ADC cannot resolve voltage differences smaller than 39 mV. In comparison, a 12-bit ADC with 4,096 discrete levels can resolve voltage differences as small as 2.4 mV.

Record Length

Record length refers to the amount of memory dedicated to storing digitized samples for postprocessing or display. In a digitizer, record length limits the maximum duration of a single-shot acquisition. For example, with a 1,000-sample buffer and a sample rate of 20 MHz, the duration of acquisition is 50 µs (the number of points multiplied by the acquisition time/point or 1,000 × 50 ns). With a 100,000-sample buffer and a sample

rate of 20 MHz, the duration of acquisition is 5 ms (100,000 × 50 ns). The NI 5102 has a buffer size of 663,000 samples. When performing a single-channel acquisition, you can use the entire available memory to capture data for a duration of 33.1 ms at 20 MS/s.

The NI 5102 (PCI, PXI) can transfer data to host memory while acquiring data, thus expanding their single-shot record length to 16 million samples on each channel.

Triggering Options

One of the biggest challenges of making a measurement is to successfully trigger the signal acquisition at the point of interest. Since most high-speed digitizers actually record the signal for a fraction of the total time, they can easily miss a signal anomaly if the trigger point is set incorrectly. The NI 5102 is equipped with sophisticated triggering options, including 256 trigger thresholds, programmable hysteresis, window triggering, trigger hold-off, and bilevel triggering on input channels as well as on a dedicated trigger channel. The NI 5102 also has two digital triggers that give you more flexibility in triggering by allowing you to connect a TTL/CMOS digital signal to trigger the acquisition. See Chapter 4, *Hardware Overview*, for more information on triggering.

Making Accurate Measurements

Choosing the correct settings for your NI 5102 requires knowing certain characteristics of the signal in consideration. These characteristics may include:

- Peak-to-peak value—This parameter, in units of volts, reflects the maximum change in signal voltage. If V is the signal voltage at any given time, then $V_{pk\text{-}to\text{-}pk} = V_{max} - V_{min}$. The peak-to-peak value affects the vertical sensitivity or gain of the input amplifier. If you do not know the peak-to-peak value, start with the smallest gain (maximum input range) and increase it until the waveform is digitized using the maximum dynamic range without clipping the signal. Refer to Appendix A, *Specifications*, for the maximum input voltage for your NI 5102. Figure 3-5 shows that a gain of 5 is the best setting to digitize a 300 mV, 1 MHz sine wave without clipping the signal.

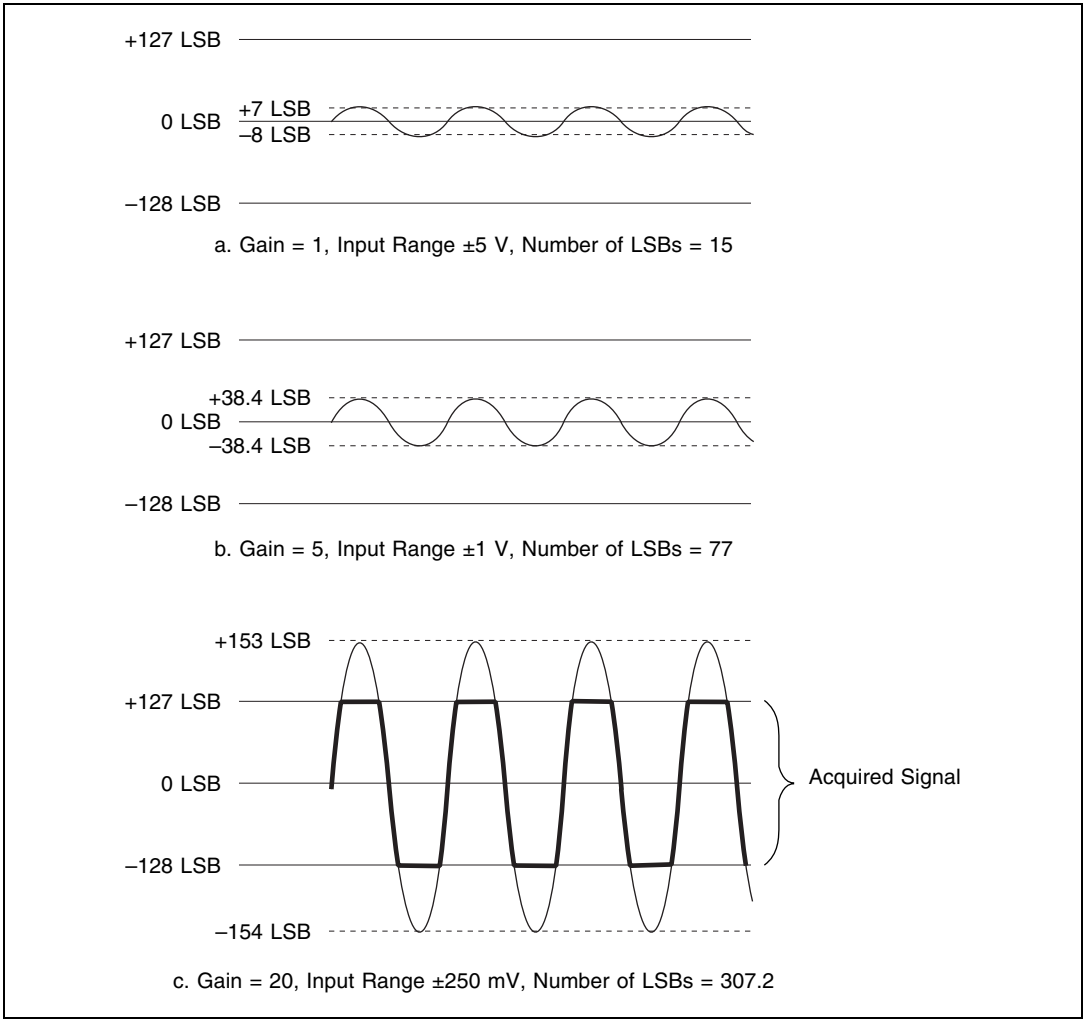


Figure 3-5. Dynamic Range of an 8-Bit ADC with Three Different Gain Settings

- Source impedance—Many digitizers and most digital storage oscilloscopes (DSOs) have a 1 MΩ input resistance in the passband with an X1 probe and a 10 MΩ input resistance with an X10 probe. If the source impedance is large, the signal will be attenuated at the amplifier input and the measurement will be inaccurate. If the source impedance is unknown but suspected to be high, change the attenuation ratio on your probe and acquire data. If the X10 measurement results in amplitude gain, your measurement may be inaccurate. To correct this, try reducing the source impedance by

buffering. See the *Understanding the Probe and Its Effects on Your Waveform* section later in this chapter for more information.

In addition to the input resistance, all digitizers, DSOs, and probes present some input capacitance in parallel with the resistance. This capacitance can interfere with your measurement in much the same way as the resistance does. You can reduce this capacitance by using an attenuating probe (X10, X100, or X1000) or an active probe. See Appendix A, *Specifications*, or your probe specifications for accurate input capacitance numbers.

- Input frequency—If your sample rate is less than twice the highest frequency component at the input, the frequency components above half your sample rate will alias in the passband at lower frequencies, indistinguishable from other frequencies in the passband. If the signal's highest frequency is unknown, you should start with the digitizer's maximum sample rate to prevent aliasing and reduce the digitizer's sample rate until the display shows either enough cycles of the waveform or the information you need.
- General signal shape—Some signals, such as sinusoidal, triangular, square, and saw tooth waves are easy to capture with ordinary triggering methods.

  Some of the more elusive waveforms, such as irregular pulse trains, runt pulses, and transients, may be more difficult to capture. You can solve this problem without using complicated signal processing techniques by using *trigger hold-off*, which lets you specify a time from the end of the last acquisition during which additional triggers are ignored.
- Input coupling—You can configure the input channels on your NI 5102 to be DC coupled or AC coupled. DC coupling allows the DC and low-frequency components of a signal to pass through without attenuation. In contrast, AC coupling removes DC offsets and attenuates the low-frequency components of a signal. This feature can be exploited to zoom in on AC signals with large DC offsets, such as switching noise on a 12 V power supply. Refer to Appendix A, *Specifications*, for the input limits that must be observed regardless of coupling.

Understanding the Probe and Its Effects on Your Waveform

Signals travel from the tip of the probe to the input amplifier and are then digitized by the ADC. This signal path makes the probe an important electrical system component that can severely affect the accuracy of the measurement. A probe can potentially influence measured amplitude and phase, and the signal can pick up additional noise on its way to the input stage. Several types of probes are available including passive, active, and current probes.

Passive Probe

The passive probe is the most widely used general-purpose oscilloscope probe. Passive probes are specified by bandwidth (or rise time), attenuation ratio, compensation range, and mechanical design aspects. Probes with attenuation, X10, X100, or X1000, have a tunable capacitor that can reduce capacitive effects at the input. The ability to cancel or minimize effective capacitance improves the probe's bandwidth and rise time. Figure 3-6 shows a typical X10 probe model. You should adjust the tunable capacitor, C_p, to obtain a flat frequency response. C_p is the probe capacitance, R_p is the probe resistance, C_{in} is the input capacitance, R_{in} is the input resistance.

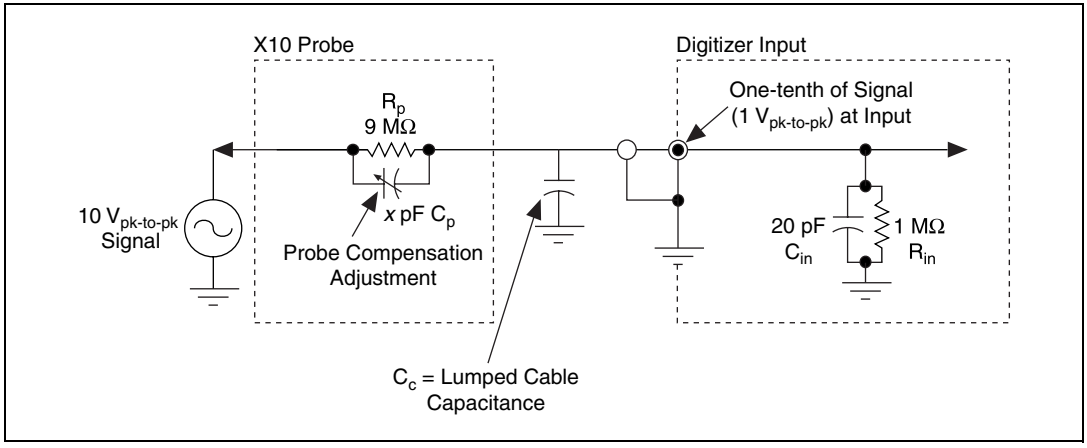


Figure 3-6. Typical X10 Probe

Analytically, obtaining a flat frequency response means:

$$R_{in}/(R_{in} + R_p) = Cp/(C_p + C_{in} + C_c)$$

It can be shown that:

$$R_{in}(C_{in} + C_c) = C_pR_p$$

or the time constant of the probe equals the time constant of the digitizer input.

How to Compensate Your Probe

Adjusting the tunable probe capacitor to get a flat frequency response is called *probe compensation*. On the NI 5102, you can select a 0–5 V, 1 kHz pulse train as reference to output on PFI1 or PFI2. Calling `niScope_ProbeCompensation` in LabVIEW, however, will only allow output to PFI1. Refer to Figure 3-7 as you follow these instructions to compensate your probe:

1. Connect the BNC end of the probe to an input channel, either CH0 or CH1 and select X10 attenuation on the body of the probe tip.
2. Attach the BNC adapter (probe accessory) to the tip of the probe.
3. Connect the SMB100 probe-compensation cable to one of the PFI lines. On the NI 5102 (PXI) this line is PFI1.
4. Attach the probe with the BNC adapter to the BNC female end of the SMB100 cable.
5. Enable the probe compensation signal on the PFI line you selected in step 3. See your application software documentation for more information how to perform this step.
6. Digitize data on the input channel, amplifying the signal until the signal starts to clip. Then go back one step so it does not clip anymore. This step ensures that you use the main dynamic range of the ADC.
7. Adjust the tunable capacitor to make the waveform look as square as possible.
8. For the most accurate measurements, compensate probes for each channel (CH0 and CH1) and use them on that channel only. Recompensate when using the same probe on a different channel.

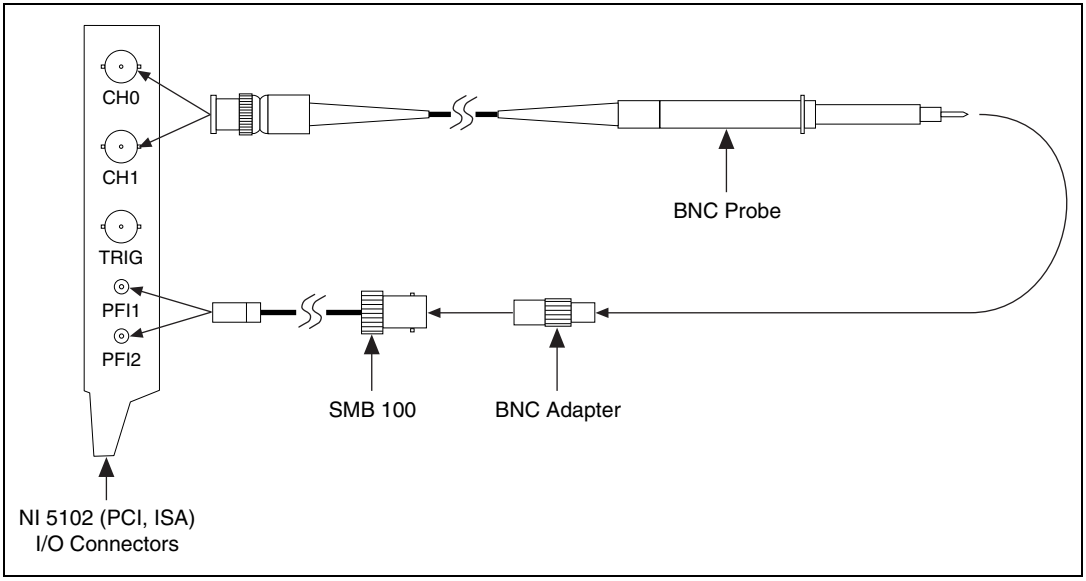


Figure 3-7. Connecting the Probe Compensation Cabling

As shown in Figure 3-8, an undercompensated probe attenuates higher frequency signals, whereas an overcompensated probe amplifies higher frequencies. Calibrate your probe frequently to ensure accurate measurements from your NI 5102.

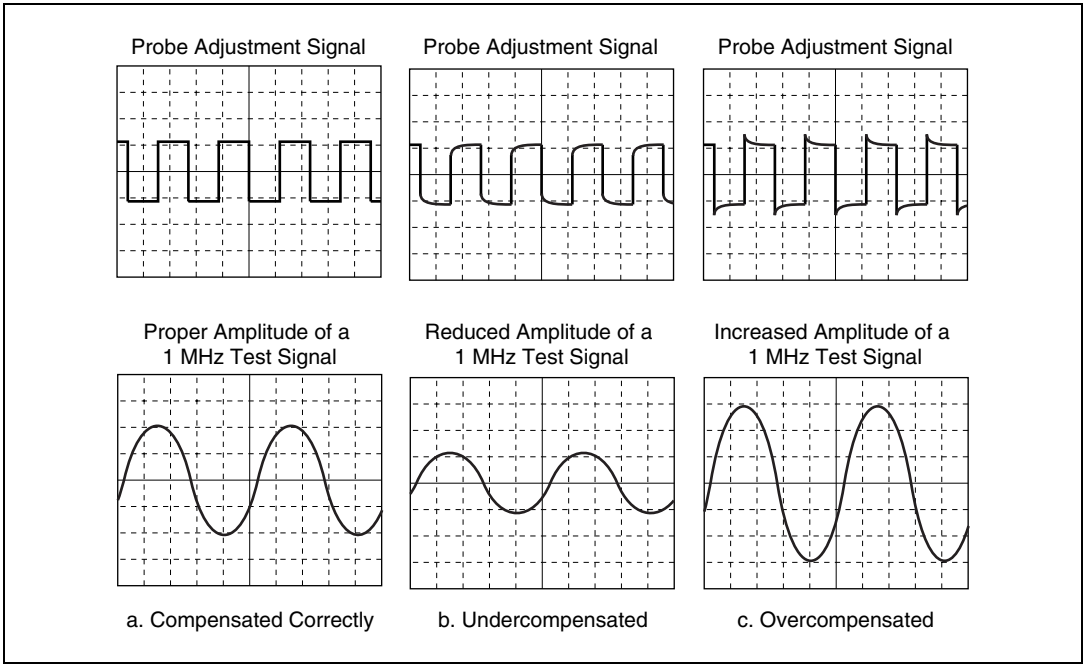


Figure 3-8. Probe Compensation Comparison

Active and Current Probes

You can also use active probes and current probes with digitizers and DSOs.

Active probes, such as differential and field-effect transistor (FET) probes, contain active circuitry in the probe itself to reject noise and amplify the signal. FET probes are useful for low-voltage measurements at high frequencies and differential probes are noted for their high common mode rejection ration (CMRR) and nongrounded reference.

Instead of using a series resistance in the loop to measure current, current probes magnetically measure AC and/or DC current flowing in a conductor. This lack of series resistance causes very little interference in the circuit being tested.

4

Hardware Overview

This chapter includes an overview of the NI 5102, explains the operation of each functional unit making up your NI 5102, and describes the signal connections.

Figure 4-1 shows a block diagram of the NI 5102 (PCI, PXI, ISA).

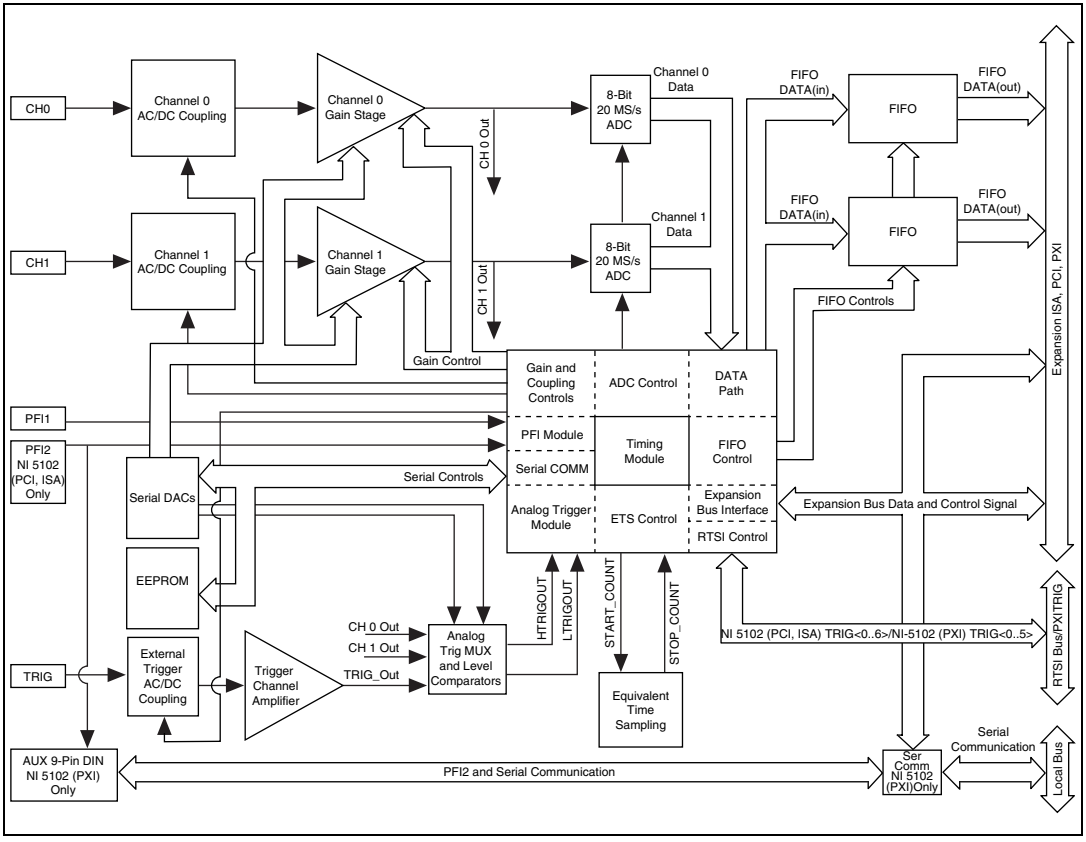


Figure 4-1. NI 5102 (PCI, PXI, ISA) Block Diagram

Figure 4-2 shows a block diagram of the NI 5102 (PCMCIA, USB).

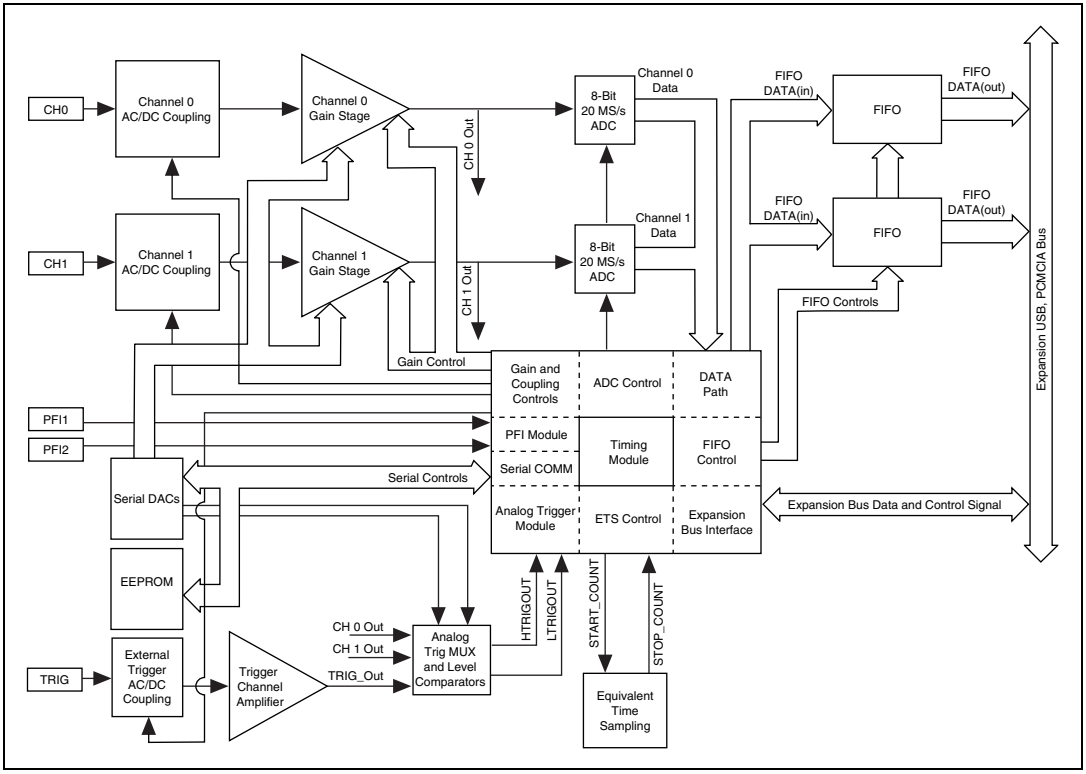


Figure 4-2. NI 5102 (PCMCIA, USB) Block Diagram

I/O Connector

- NI 5102 (PCI, ISA, PCMCIA, USB)

  These NI 5102 devices have two standard BNC female connectors for CH0 and CH1 analog input connections, one standard BNC female connector for the TRIG channel, and two standard SMB female connectors for the multipurpose digital timing and triggering signals, PFI1 and PFI2.

The NI 5102 (PCI, ISA) gives you direct BNC connectivity on the bracket, as shown in Figure 4-3.

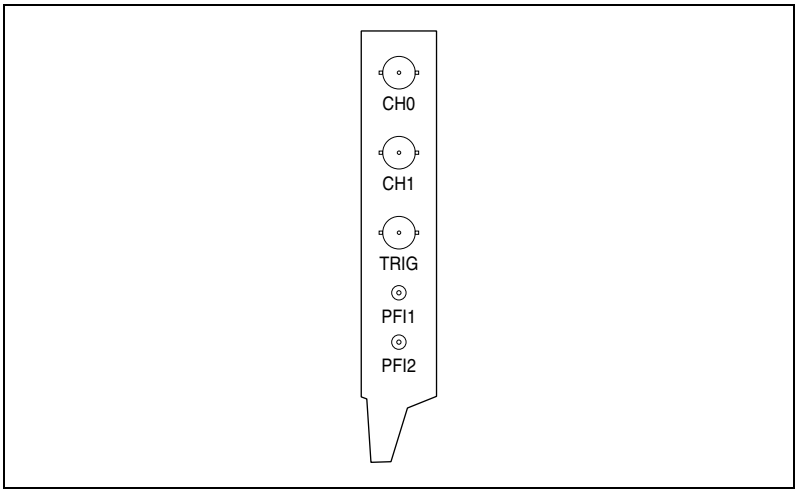


Figure 4-3. NI 5102 (PCI, ISA) I/O Connectors

Use the cable assembly provided for these connections on the NI 5102 (PCMCIA), as shown in Figure 4-4.

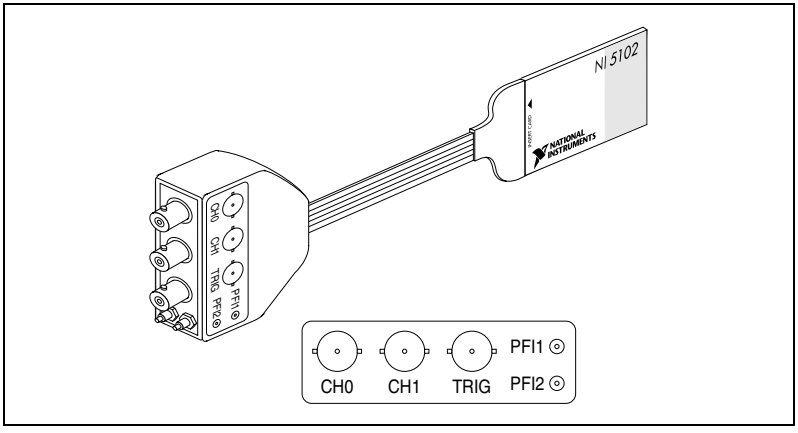


Figure 4-4. NI 5102 (PCMCIA) I/O Connectors

The NI 5102 (USB) gives you direct BNC connectivity, as shown in Figure 4-5.

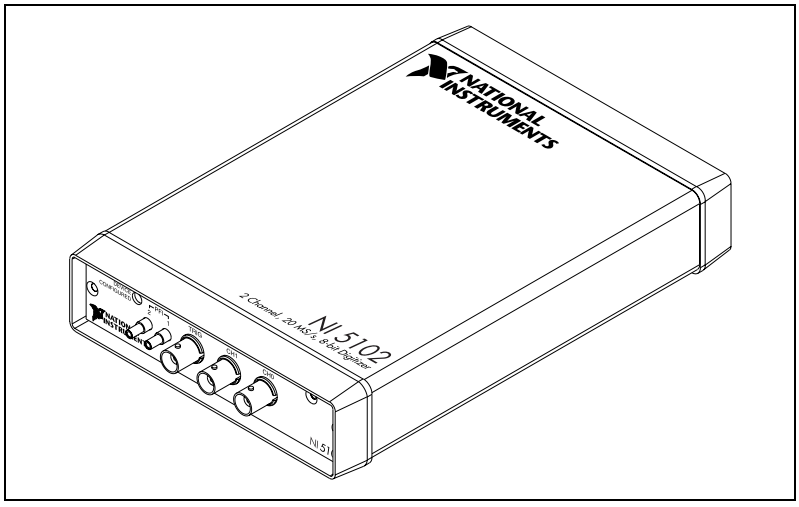


Figure 4-5. NI 5102 (USB) I/O Connectors

- NI 5102 (PXI)

  The NI 5102 (PXI) has two standard BNC female connectors for CH0 and CH1 analog input connections, one standard BNC female connector for the TRIG channel, one standard SMB female connector for a multipurpose digital timing and triggering signal, PFI1, and a 9-pin mini-DIN connector, AUX, for serial communication or PFI2. The NI 5102 (PXI) gives you direct BNC connectivity on the bracket, as shown in Figure 4-6.

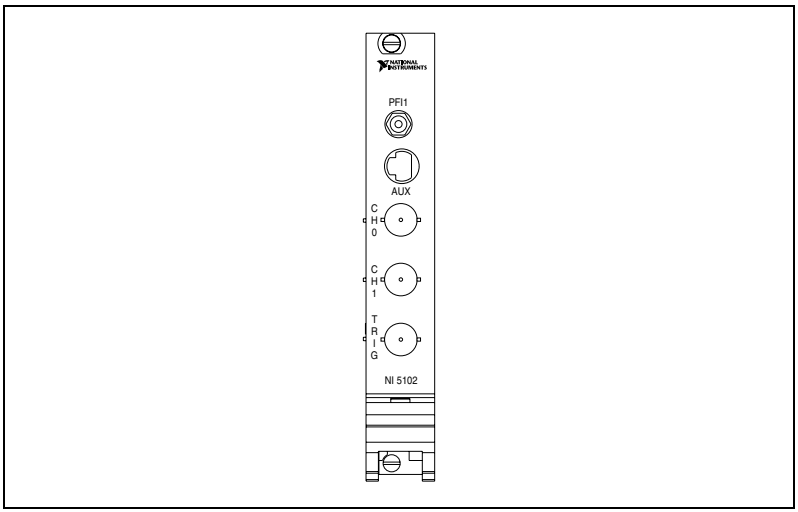


Figure 4-6. NI 5102 (PXI) I/O Connectors

Signal Connections

You can use CH0 and CH1 to digitize data as well as to trigger an acquisition. Use the TRIG channel for an external analog trigger only; data on the TRIG channel cannot be digitized. PFI1 and PFI2 are digital signals that you can use for timing-critical applications. When used as inputs, PFI lines can trigger an acquisition and/or allow an external scan clock connection. When used as outputs, PFI lines can output Start Trigger, Stop Trigger, Scan Clock, and End of Acquisition signals as well as Analog Trigger Circuit Output, frequency output, and TTL low and high voltage information. Signal names and descriptions vary depending on the acquisition mode you are using. See the *Acquisition Modes* section later in this chapter for more information on timing and triggering.

Table 4-1. I/O Connector Signal Descriptions

Signal	Description
CH0, CH1	Digitizes data and triggers acquisitions
TRIG	Used for external analog triggering
PFI1, PFI2	Software-configurable digital triggers, external scan clock, or digital outputs
AUX for NI 5102 (PXI) only	Serial communication or PFI2 (with optional cable)

Serial Communications Port (AUX)

- NI 5102 (PXI)

The serial communication port, AUX, provides +5V and GND for applications that may require up to 100 mA of current operation and PF12 for triggering.

PFI2 has the same functionality as described above, but it is overloaded on TRIG0 (SCANCLK) on the mini-DIN connector and is accessible only through the optional 9-pin mini-DIN to BNC female cable adapter.

Analog Input

The two analog input channels are referenced to common ground in bipolar mode. These settings are fixed; therefore, neither the reference nor the polarity of input channels can be changed. You cannot use CH0 or CH1 to make differential measurements or measure floating signals unless you subtract the digital waveforms in software. For accurate measurements, make sure the signal being measured is referenced to the same ground as your NI 5102 by attaching the probe's ground clip to the signal ground. Table 4-2 shows the input ranges available on CH0 and CH1.

Table 4-2. CH0 and CH1 Input Ranges

Gain	Input range			
	X1 Probe	**X10 Probe**	**X100 Probe**	**X1000 Probe**
1	±5 V (default setting)	±50 V	±500 V	±5000 V
5	±1 V	±10 V	±100 V	±1000 V
20	±0.25 V	±2.5 V	±25 V	±250 V
100	±50 mV	±0.5 V	±5 V	±50 V

Note The X10, X100, and X1000 designations are used to indicate a signal attenuation rather than amplification. For example, with a X100 probe and a gain of 1, if you measure a 400 V signal, the NI 5102 will receive 4 V (400 V/100 = 4 V) at its input connector.

The TRIG channel has a fixed input range of ±5 V. All NI 5102 digitizers power up with a default gain of 1, thereby allowing the largest input range available. TRIG channel range values are the same as the gain of 1 values in Table 4-2.

The CH0, CH1, and TRIG channels have a software-programmable coupling selection between AC and DC. Use AC coupling when your AC signal contains a large DC component. Without AC coupling, it is difficult to view details of the AC component with a large DC offset and a small AC component, such as switching noise on a DC supply. If you enable AC coupling, you remove the large DC offset for the input amplifier and amplify only the AC component. This technique makes effective use of dynamic range to digitize the signal of interest.

The *low-frequency corner* in an AC-coupled circuit is the frequency below which signals are attenuated by at least 3 dB. The low-frequency corner is 11 Hz with an X1 probe, 1.1 Hz with an X10 probe, 0.11 Hz with anX100 probe, and 4 Hz with an X1000 probe.

When changing coupling on the NI 5102 digitizers, the input stage takes a finite time to settle, as shown in Table 4-3.

Table 4-3. AC/DC Coupling Change Settling Rates with NI Probes

Action	Time Constant
Switching from AC to DC settling time	0.5 ms
Switching from DC to AC X1 probe time constant X10 probe time constant	 15 ms 150 ms



Caution When switching coupling from DC to AC, returned data is accurate about 20 time constants after switching to AC. This delay is based on switching to AC and, at the same time, switching from a gain of 1 to a gain of 100. NI-SCOPE does not provide the delay to account for settling time; therefore, acquisitions immediately following a coupling change may yield incorrect data.

ADC Pipeline Delay

The ADC on the NI 5102 is a pipelined flash converter with a maximum conversion rate of 20 MS/s. The pipelined architecture imposes a 2.5 Scan Clock cycle delay to convert analog voltage into a digital value, as shown in Figure 4-7.

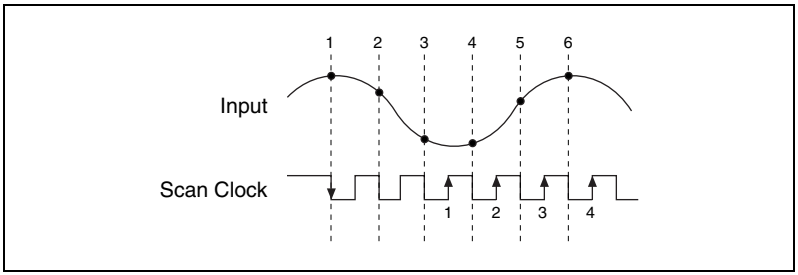


Figure 4-7. Scan Clock Delay

In reference to the Scan Clock signal, the digital value corresponding to the first conversion (the first falling edge of the Scan Clock signal) outputs synchronously with the third rising edge of the Scan Clock signal.

Using a pipelined architecture also introduces a lower limit on the scan rate. For the NI 5102, the accuracy starts to degrade below about 1 kS/s.

The NI 5102 automatically adjusts for pipelined delay when you use the internal scan clock. If you use an external scan clock, you must provide a free-running clock to ensure reliable operation. You must also follow timing specifications on the external scan clock as described in Appendix A, *Specifications*.

Acquisition Modes

The NI 5102 supports two acquisition modes—pretrigger acquisition and posttrigger acquisition.

Posttrigger Acquisition

In posttrigger acquisition mode, the hardware acquires a number of scans after the Start Trigger occurs. When the trigger occurs, the input signal is digitized and the desired number of scans are stored in onboard memory. Table 4-4 shows the minimum and maximum number of samples the NI 5102 can acquire.

Table 4-4. Possible Number of Samples for Posttriggered Scans

Number of Channels	NI 5102 (PCI, PXI)		NI 5102 (ISA, PCMCIA, USB)	
	Min	Max	Min	Max
One	1	16,777,088*	1	663,000
Two	1	16,777,088*	1	331,500
* Dependent on available memory				

Note If Scan Clock is externally supplied, you must supply a free-running clock for proper operation.

On the NI 5102 (ISA, PCMCIA, USB), data transfer takes place after an acquisition ends, limiting the scan count to the size of the onboard memory.

On the NI 5102 (PCI, PXI), data can be moved very quickly from the digitizer to host memory while an acquisition is in progress. The NI 5102 (PCI, PXI) takes advantage of the NI MITE on the application-specific integrated circuit (ASIC) to master the PCI bus and transfer data acquired on both channels to PC memory in real time without losing data. This technology lets you acquire more data than 663,000 samples, the size of the onboard memory. This property of the PCI bus extends the maximum scan count to 16 million scans.

Figure 4-8 shows the timing signals involved in a posttrigger acquisition. In this example, the hardware is programmed to acquire 10 posttriggered scans.

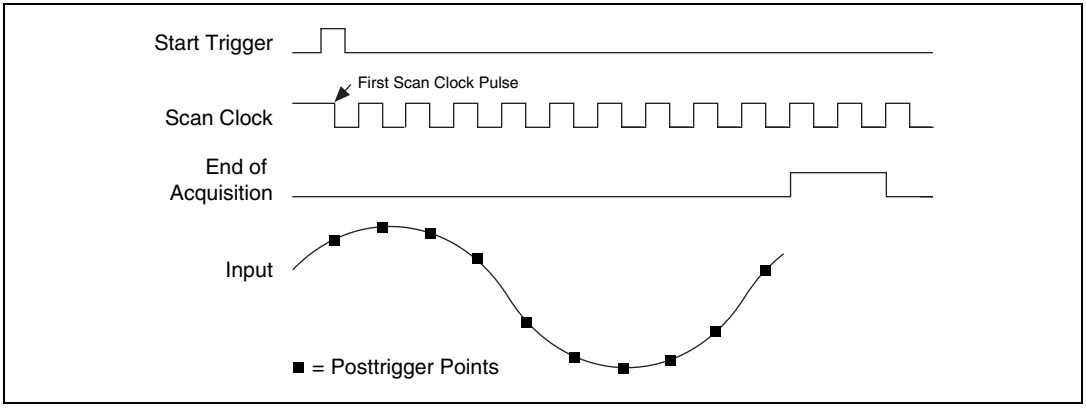


Figure 4-8. Posttrigger Acquisition

Table 4-5 describes the posttrigger acquisition signals.

Table 4-5. Posttrigger Acquisition Signals

Signal	Description
Start Trigger	Triggers the acquisition. It can be generated through software, or CH0, CH1, TRIG, PFI1, and PFI2, or any of the seven RTSI bus trigger lines. RTSI bus trigger lines are available only on the NI 5102 (PCI, PXI, ISA).
Scan Clock	Causes the ADC to convert the input signal into digital data. This signal is also used in the memory controller to write the data into onboard memory. This signal can be generated internally, with a 24-bit counter clocked with a 20 MHz signal to generate pulses from 20 MHz to 1.19 Hz. The 24-bit counter provides a wide choice of valid frequencies for the Scan Clock signal. In addition, Scan Clock can also be selected from CH0, CH1, TRIG, PFI1, and PFI2, or any of the seven RTSI bus trigger lines. RTSI bus trigger lines are available only on the NI 5102 (PCI, PXI, ISA).
End of Acquisition	Indicates end of acquisition to the control logic in the hardware. It is generated from a counter that keeps track of the number of points remaining in the acquisition. It can be exported from the device on the PFI lines.

Pretrigger Acquisition

In pretrigger acquisition mode, the device acquires a certain number of scans, called the pretrigger scan count, *before* the trigger occurs. After satisfying the pretrigger scan count requirement, hardware keeps acquiring data and stores it in a circular buffer implemented in onboard memory. The size of the circular buffer equals the pretrigger scan count. When the trigger occurs, hardware acquires and stores the posttrigger scans and the acquisition terminates. Table 4-6 shows the minimum and maximum number of samples available on the NI 5102 in pretriggered mode.

Table 4-6. Possible Number of Samples for Pretriggered Mode

Number of Channels	NI 5102 (PCI, PXI)		NI 5102 (ISA, PCMCIA, USB)	
	Min	**Max**	**Min**	**Max**
One				
Pretriggered scans	1	663,000	1	663,000 – A
Posttriggered scans	1	16,777,216*	1	663,000 – B
Two				
Pretriggered scans	1	331,500	1	331,500 – A
Posttriggered scans	1	16,777,216*	1	331,500 – B

* Dependent on available memory

A – The number of posttriggered scans

B – The number of pretriggered scans

Note If Scan Clock is externally supplied, a free-running clock must be used for proper operation.

Figure 4-9 shows the relevant timing signals for a typical pretriggered acquisition. The illustration represents five pretrigger and five posttrigger scans, and above-high-level analog triggering is used. See the *Analog Trigger Circuit* section later in this chapter for more information on analog trigger types.

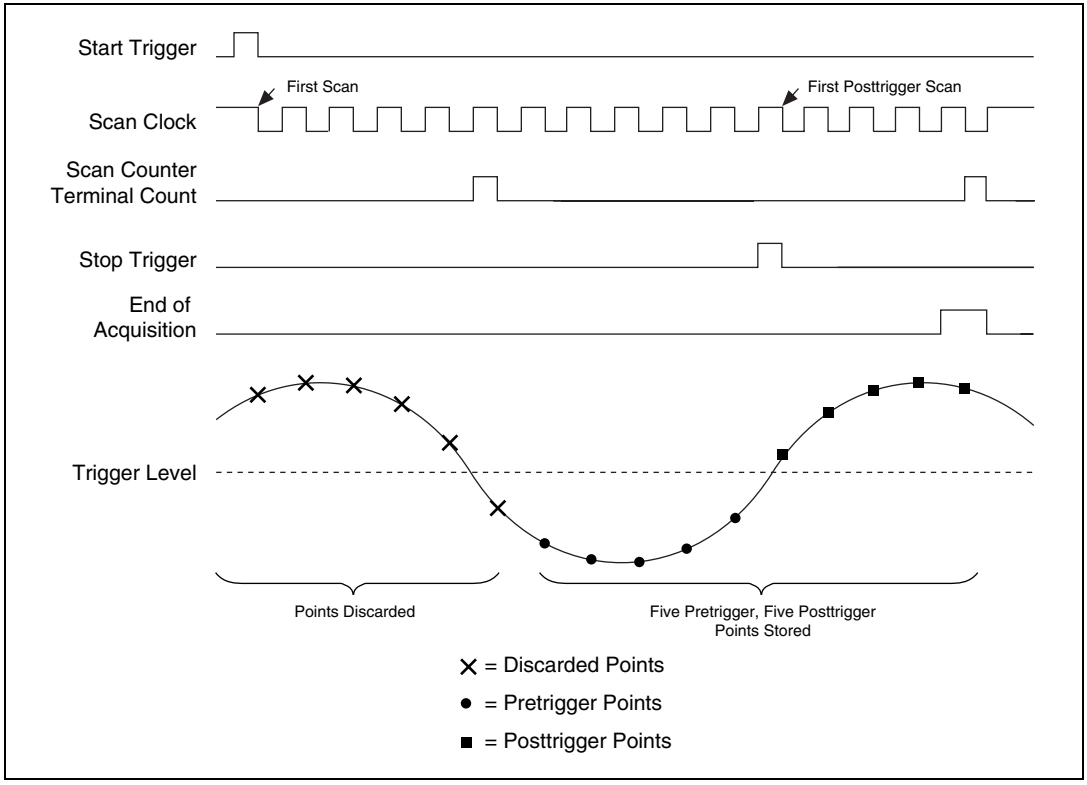


Figure 4-9. Pretrigger Acquisition

Table 4-7 describes the pretrigger acquisition signals.

Table 4-7. Pretrigger Acquisition Signals

Signal	Description
Start Trigger	Starts data acquisition. In pretrigger mode, the Start Trigger signal enables the storage of pretrigger data. Start Trigger can only be generated through software in pretrigger mode.
Scan Clock	Causes the ADC to convert the input signal into digital data. This signal is also used in the memory controller to write the data into onboard memory. This signal can be generated internally, with a 24-bit down counter clocked with a 20 MHz signal to generate pulses from 20 MHz to 1.19 Hz. The 24-bit counter provides a wide choice of valid frequencies for the Scan Clock signal. In addition, Scan Clock can also be selected from CH0, CH1, TRIG, PFI1, and PFI2, or any of the seven RTSI bus trigger lines. RTSI bus trigger lines are available only on the NI 5102 (PCI, PXI, ISA).
Scan Counter Terminal Count	Is an internally generated signal that pulses once to indicate that the pretrigger sample count requirement is met. Between the time when this signal pulses and the Stop Trigger occurs, hardware overwrites the oldest points in memory with the most recent points in a circular fashion. All Stop Triggers occurring before Scan Counter Terminal Count are ignored by the device.
Stop Trigger	Terminates the acquisition sequence after acquiring the posttrigger sample count. This trigger can be generated through software, or CH0, CH1, TRIG, PFI1, and PFI2, or any of the seven RTSI bus trigger lines. RTSI bus trigger lines are available only on the NI 5102 (PCI, PXI, ISA).
End of Acquisition	Indicates end of acquisition to the control logic in the hardware. It is generated from a counter that keeps track of points remaining to acquire. It can be exported from the device on the PFI lines.

Trigger Sources

The Scan Clock, Start Trigger, and Stop Trigger signals can be generated through software or supplied externally as digital triggers or as analog triggers on one of the input channels or the TRIG channel. Figure 4-10 shows the different trigger sources. In addition, Scan Clock is available from a source (counter) internal to the NI 5102.

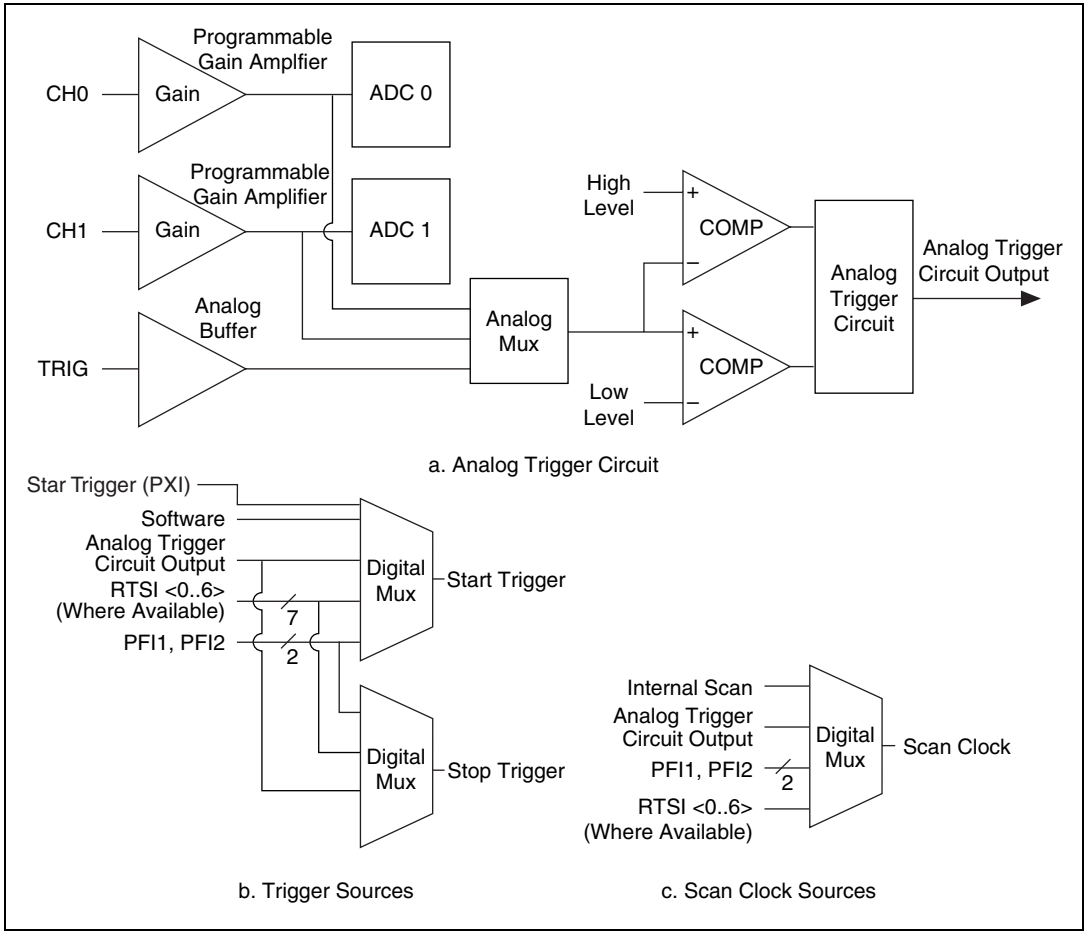


Figure 4-10. Scan Clock, Start Trigger, and Stop Trigger Signal Sources

Analog Trigger Circuit

The NI 5102 contains a sophisticated analog trigger circuit that accepts boolean outputs from level comparators and makes intelligent decisions about the trigger. Several triggering modes are available, including edge, window, and hysteresis. For information on configuring trigger functions, see the *Triggering Functions and Parameters* section in Chapter 3, *Common Functions and Examples,* of your *NI-SCOPE Software User Manual*.

Trigger Hold-off

Trigger hold-off is the length of time that the NI 5102 waits after finishing an acquisition before it may accept another trigger. Hold-off is provided in hardware using a 24-bit down counter clocked by a 2.5 MHz internal timebase. With this configuration, you can select a hardware hold-off value of 800 ns to 6.71 s in increments of 400 ns.

When an acquisition is in progress, the counter is loaded with a digital value that corresponds to the desired hold-off time. The End of Acquisition signal triggers the counter to start counting down. Before the counter reaches its terminal count (TC), all triggers are rejected in hardware. At TC, the hold-off counter reloads the hold-off value and prepares to accept the next trigger. Figure 4-11 shows a timing diagram of signals when hold-off is enabled.

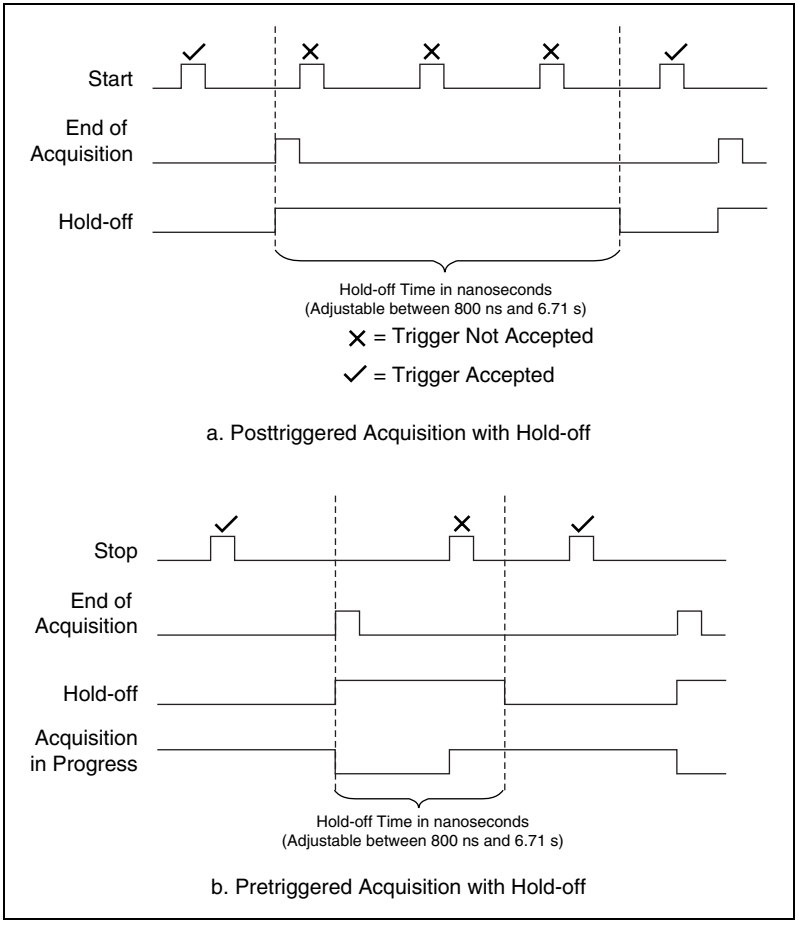


Figure 4-11. Pretrigger and Posttrigger Acquisitions with Hold-off

Note When you use trigger hold-off, you cannot calibrate your probe or generate an asynchronous frequency at the same time. The counter that is used to implement trigger hold-off also generates the probe calibration signal and the asynchronous pulse train.

Random Interleaved Sampling

The NI 5102 supports Random Interleaved Sampling (RIS), a form of Equivalent Time Sampling (ETS) which allows multiplication of the maximum real-time sampling rate. The maximum interpolation factor on the NI 5102 is 50, resulting in a maximum effective sampling rate of 1 GS/s. At this rate, the ratio of logical bins to physical bins is approximately 1:9. The minimum RIS rate is 40 MS/s.

To reconstruct the waveform with RIS, you need to know the RIS OFFSET, which is the minimum value that the Time-to-Digital Converter (TDC) can return, and the range of values, RIS GAIN, which is the maximum TDC value minus the minimum TDC value.

RIS OFFSET and RIS GAIN may vary slightly from digitizer to digitizer. Both these parameters are computed individually for each digitizer at the factory and the values are stored in the onboard EEPROM.

Use RIS GAIN to determine the number of physical bins per logical bin for the desired interpolation factor. You could use RIS OFFSET to start the waveform reconstruction at the origin, but this parameter may drift over time and temperature, which could result in an inaccurate waveform.



Note ETS and RIS work only with repetitive signals.

For an in-depth discussion of these concepts and how to use RIS, see Chapter 5, *Tasks and Examples*, in your *NI-SCOPE Software User Manual*.

Calibration

Calibration is the process of minimizing measurement errors by making small circuit adjustments. All NI 5102 digitizers come factory calibrated to the levels indicated in Appendix A, *Specifications*. However, your digitizer needs to be periodically recalibrated in order to maintain its specified accuracy. You have two choices for recalibration, internal (or self) calibration, and external calibration. A third option, external restore, restores the factory settings and should be used only in the event of an internal calibration failure.

Internal calibration is executed with an NI-SCOPE software call or a LabVIEW VI. It requires no external connections and adjusts *only* the timing for RIS acquisitions. It should be performed upon installation of

your NI 5102 and afterwards whenever operating environment conditions change.

Externally recalibrate the NI 5102 when its interval has expired. This requires connecting a precision reference to your device, and is normally performed at NI or a metrology lab. See Appendix A, *Specifications*, for more information about calibration intervals, and your *NI 5102 Calibration Procedure* for detailed external calibration instructions. This procedure is available at `C:\VXIpnp\Win95\NISCOPE\Documents\ni5102cal.pdf`.

You may choose to write your own external calibration procedure in NI-SCOPE. Refer to your *NI-SCOPE Software User Manual* for more information about calibration.

RTSI Bus Trigger and Clock Lines

- NI 5102 (PCI and ISA)

  The RTSI bus (not available on the NI 5102 PCMCIA or USB) allows NI digitizers to synchronize timing and triggering on multiple devices. The RTSI bus has seven bidirectional trigger lines and one bidirectional clock signal.

  You can program any of the seven trigger lines as inputs to provide Start Trigger, Stop Trigger, Sample Clock and Board Clock signals sourced from a master device. Similarly, you can program a master NI 5102 to output its internal Start Trigger, Stop Trigger, Scan Clock, and Analog Trigger Circuit Output signals on any of the trigger lines, as shown in Figure 4-12.

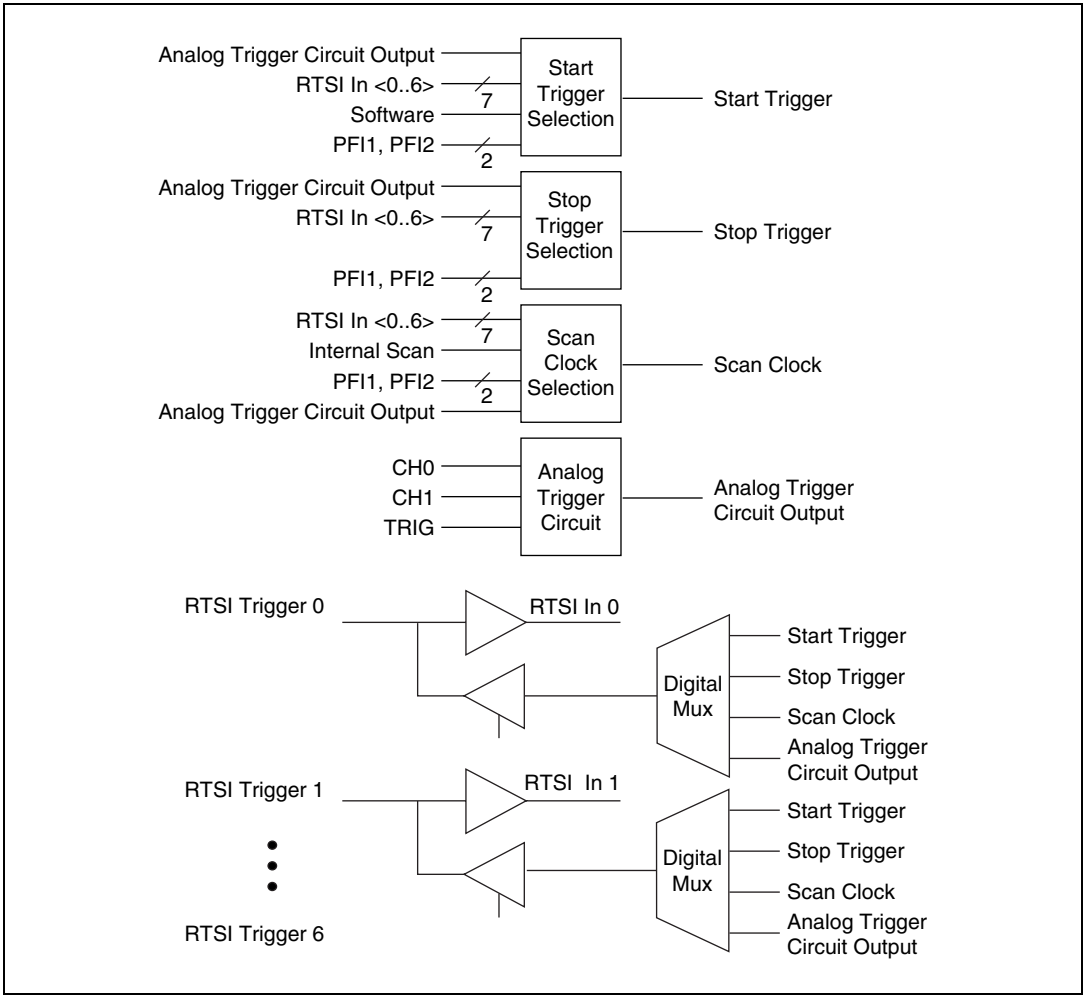


Figure 4-12. RTSI Bus Trigger Lines

The RTSI bus clock line is a special clock line on the RTSI bus that can only carry the timebase of the master to the slaves. For the smallest jitter between measurements on different devices, you should configure the slaves to use the RTSI bus clock from the master NI 5102.

- NI 5102 (PXI)

  The NI 5102 (PXI) uses the PXI Trigger <0..5> to carry RTSI Trigger <0..5> and uses PXI Trigger 7 to carry the RTSI clock signal to all other PXI slots in the system. RTSI Trigger 6 is reserved for use with PXI Star Trigger, which the NI 5102 can receive but may not drive.

PFI Lines

All NI 5102 digitizers have two multipurpose programmable function digital input/output lines, PFI1 and PFI2, that you can use for external timing and triggering or outputting various signals. You can individually select the direction of these lines to be input or output.

PFI Lines as Inputs

PFI1 or PFI2 can be selected as inputs for the Start Trigger, Stop Trigger, and Scan Clock signals. On the NI 5102 (PXI), PFI2 is accessible through the optional 9-pin mini-DIN to BNC female cable adapter. Unless your application requires the PFI2 signal to be passed through to the PXI backplane on TRIG0 (SCANCLK), disable the backplane scan clock via your application software (reset state is disabled).

PFI Lines as Outputs

On the NI 5102 (PXI), PFI2 is accessible through the optional 9-pin mini-DIN to BNC female cable adapter. PFI1 or PFI2 can be selected to output the following digital signals:

- Start Trigger—This signal is synchronized to the 20 MHz timebase. When the Start condition is satisfied, either through a software, analog, or digital trigger, Start Trigger will transition high for 100 ns (two clock periods of the 20 MHz timebase) and transition back to its idle state.
- Stop Trigger—This signal is synchronized to the 20 MHz timebase. When the Stop condition is satisfied, either through an analog or digital trigger, Stop Trigger will transition high for 100 ns (two clock periods of the 20 MHz timebase) and transition back to its idle state.
- Scan Clock—This signal is also the clock to the ADC that represents the rate at which the input is sampled. The default state of this signal is high.
- End of Acquisition—This signal is generated internally to indicate to internal state machines that acquisition has ended. End of Acquisition, synchronous to Scan Clock, pulses high for two Scan Clock periods at the end of acquisition. This signal may be useful to trigger external circuits for timing critical applications.

- Analog Trigger Circuit Output—This signal is the digital output of the Analog Trigger Circuit on the NI 5102. The frequency and duty cycle of this signal depends on the trigger channel, the trigger levels, polarity, and triggering mode. For more information, see the *Analog Trigger Circuit* section earlier in this chapter or your *NI-SCOPE Software User Manual.*
- Frequency Output—This signal is a digital pulse train with programmable frequency. The most common application of frequency output for the NI 5102 is to provide a signal for compensating the probe. You can select two timebases to generate this frequency as follows:
  - 7.16 MHz (asynchronous to 20 MHz internal timebase)
  - 1.25 MHz (synchronous to 20 MHz internal timebase)

  The NI 5102 uses a 16-bit counter to programmatically select frequency at the output. The pulse train frequency as a function of the counter value can be expressed as:

  $$\text{Frequency} = \text{timebase}/\text{divide_ratio}$$

  where divide_ratio = 3 .. 65,535

  Alternatively, to compute divide_ratio for a particular frequency, the relationship is:

  $$\text{divide_ratio} = \text{timebase}/\text{frequency}$$

  For example, to generate a 1 kHz pulse train, common for probe compensation, select the following parameters:
  - timebase = 1.25 MHz
  - divide_ratio = 1,250
- Low—This is the TTL low voltage referenced to the ground potential of the computer. This is a signal at logic level low. Do not use this as GND for your circuit.
- High—This is the TTL high voltage referenced to the ground potential of the computer. This is a signal at logic level high. Do not use this as VCC for your circuit.

Caution Refer to the output drive specification of PFI lines in Appendix A, *Specifications*. Failure to observe these limits may severely damage your NI 5102.

Master/Slave Operation

You can use two or more NI 5102 digitizers in one system to increase the number of channels for your application by synchronizing devices over the RTSI bus or PFI lines.

Use the RTSI bus for synchronizing two or more NI 5102 (PCI, PXI, ISA) devices. For the NI 5102 (PCMCIA, USB), you must use the PFI lines.

Restrictions

To ensure proper master/slave operation of your NI 5102, you must observe the following restrictions:

- You must use all channels for acquisition. For example, if you want to use three channels at a time, you cannot use two channels on the master and one channel on the slave, you must use four channels for data acquisition and discard data on the fourth channel.
- The desired pretrigger number of scans and total number of scans must be a multiple of four. This is a hardware limitation.
- There is a maximum of one sample clock timing jitter between master and slave devices.

Connecting Devices

♦ NI 5102 (PCI, PXI, ISA)

You can synchronize NI 5102 (PCI, PXI, ISA) devices over the RTSI bus. You can configure a system where a NI 5102 (PCI or ISA) can be the master device controlling a mix of NI 5102 (PCI, ISA) slave devices. The NI 5102 (PXI) can control only other NI 5102 (PXI) devices. The NI 5102 (PXI) has the RTSI connectivity on the bus connector; the optional RTSI bus cable is not needed. However, you need a RTSI bus cable to synchronize two or more NI 5102 (PCI or ISA) digitizers over the RTSI bus as follows:

1. If you are using multiple NI 5102 (PXI) digitizers, skip this step. If you are using the NI 5102 (PCI or ISA), connect the master device with the slave device over the RTSI connector. The cable and connector are keyed so there is only one way to insert the cable in the connector.
2. Ensure that no other device in the system is configured to output its internal timebase on the RTSI bus clock line. The safest approach is to restart your system, if possible.

3. Program the master device to output its internal timebase on the RTSI bus clock line.
4. Program the master device to output its Scan Clock and Stop Trigger on unused RTSI bus trigger lines.
5. Program the slave device to use RTSI bus clock as its main timebase.
6. Program the slave device to use external Scan Clock and external Stop Trigger on RTSI bus trigger lines selected in step 4.
7. Arm the slave device for acquisition before arming the master device.

- NI 5102 (PCMCIA, USB)

  You need two SMB200 cables (optional) and two NI 5102 (PCMCIA) or NI 5102 (USB) devices with cable assemblies to create a four-channel digitizer as follows:

  1. Connect PFI1 of the master device to PFI1 of the slave device with the SMB200 cable.
  2. Connect PFI2 of the master device to PFI2 of the slave device with the SMB200 cable.
  3. Configure PFI1 of the master device to output Scan Clock and PFI2 of the master device to output Stop Trigger.
  4. Configure the slave device to use external scans on PFI1, external Stop Trigger on PFI2, and software Start Trigger.
  5. Arm the slave device for acquisition before arming the master device.

  You cannot use the PFI1 and PFI2 lines on master and slave devices for any other purpose when synchronizing two NI 5102s.

A

Specifications

This appendix lists the specifications of the NI 5102. These specifications are typical at 25 °C unless otherwise stated. The operating temperature range is 0 to 50 °C.

Input Characteristics

Number of input channels ..... 2 single-ended, simultaneously sampled

Input impedance ..... 1 MΩ ±1% in parallel with 25 pF ±10 pF (Impedance increases with attenuating probes) CH0, CH1, TRIG

ADC resolution ..... 8 bits, 1 in 256

Maximum sample rate

- Internal ..... 20 MS/s each channel in realtime mode
- External sample clock ..... 20 MS/s
  - Minimum high or low time ..... 24 ns
- RIS mode ..... 1 GS/s

Minimum sample rate ..... 1 kS/s (internal/external)

Maximum input range ..... ±5000 V, DC + peak AC < 5 Mhz (with a X1000 probe)
±500 V, DC + peak AC < 15 Mhz (with a X100 probe)
±50 V, DC + peak AC < 15 Mhz (with a X10 probe)
±5 V, DC + peak AC < 15 Mhz (with a X1 probe)

Input signal ranges (CH0, CH1)
(without probe attenuation) .....±5 V at gain of 1
±1 V at gain of 5
±0.25 V at gain of 20
±50 mV at gain of 100

Input coupling.....AC or DC, software-selectable

Overvoltage protection .....±42 V (DC + peak AC < 10Khz without external attenuation)
CH0, CH1, TRIG only

Onboard FIFO memory depth .....663,000 samples

Max waveform buffer.....Up to 16 million samples on each channel on NI 5102 (PCI, PXI) with bus mastering, depends on available host memory
663,000 samples on NI 5102 (ISA, PCMCIA)

Data transfers.....Programmed I/O supported on all boards; direct-to-memory burst transfers with PCI bus mastering on NI 5102 (PCI, PXI) only

Timebase System

Timebase.....20 MHz

Clock accuracy .....100 ppm

Interpolator resolution .....1 ns

External clock.....RTSI TRIG<1..6> or PFI<1..2>; Frequency ≤ 20 MHz with a 50% duty cycle; RTSI<0..6> and PFI<1..2> are CMOS/TTl inputs only.

Transfer Characteristics

Relative accuracy ..... ±1 LSB typ, ±1.8 LSB max

Differential nonlinearity..... ±0.3 LSB typ, ±0.5 LSB max

No missing codes ..... 8 bits guaranteed

Offset error after calibration ..... ±1.5 LSB max

Gain error after calibration..... ±1% max

DC accuracy ..... ±2.5% of full scale at all gains

Dynamic Characteristics

Bandwidth

Small signal (–3 dB) ..... 15 MHz typ

Large signal (2% THD) ..... 10 MHz typ

AC coupling low frequency cut-off..... 11 Hz (1.1 Hz with X10 probe)

Settling for full-scale step to ±1% full-scale range ..... 50 ns typ

System noise ..... 0.5 LSB rms typ

Crosstalk..... –60 dB

S/H Characteristics

Interchannel skew ..... 1 ns

Aperture jitter..... 1 ns rms

Stability

Recommended warmup time ..... 15 minutes

Offset temperature coefficient ..... (1 mV/°C)/gain + 30 µV/°C

Gain temperature coefficient..... 50 ppm/°C

Timebase accuracy ..... 100 ppm over operating temperature range

Triggers

Analog

Source .....CH0, CH1, TRIG

Level .....256 levels between ±Full-scale for CH0 and CH1; ±5 V for TRIG; software-selectable

Slope .....Positive or negative, Software-selectable

Resolution .....8 bits, 1 in 256

Hysteresis.....Software-programmable, up to full-scale

Bandwidth.....15 MHz

Trigger hold-off .....800 ns to 6.71 seconds

Digital (PFI1 and PFI2)

Compatibility .....TTL/CMOS

Response .....Rising or falling edge; software-selectable

Pulse width .....10 ns min

DC characteristics over operating range

Symbol	Parameter	Conditions	Min	Max
V_{IH}	Input HIGH voltage	—	2.0 V	V_{cc}+ 0.5 V
V_{IL}	Input LOW voltage	—	–0.5	0.8 V
V_{OH}	Output HIGH voltage	I_{OH} = –4 mA I_{OH} = –16 mA I_{OH} = –10 µA	3.7 V 2.4 V VCC–0.1 V	—
V_{OL}	Output LOW voltage	I_{OL} = 16 mA I_{OL} = 10 µA	—	0.45 V 0.1 V

Symbol	Parameter	Conditions	Min	Max
C_{in}	Input capacitance (nominal)	—	—	10 pF
I_{OS}	Output short circuit current*	V_O = GND V_O = Vcc	–15 mA 40 mA	–120 mA 210 mA
* Only one output at a time; duration should not exceed 30 s.				

RTSI (NI 5102 for PCI, PXI, ISA Only)

Trigger lines ..... 7 I/O (6 I/O on the PXI-5102)

Clock lines..... 1

Power Consumption

NI 5102 (PCI) 5 V DC (±5%)..... 500 mA typ

NI 5102 (PXI) 5 V DC (±5%)..... 550 mA typ

NI 5102 (ISA) 5 V DC (±5%)..... 300 mA typ

NI 5102 (PCMCIA) 5 V DC (±5%)..... 260 mA typ, active
60 mA standby

NI 5102 (USB)

External power supply ..... 4 W max

Physical

PCMCIA card type..... Type II

Dimensions

NI 5102 (PCI) ..... 10.67 by 17.45 cm
(4.2 by 6.87 in.)

NI 5102 (PXI) ..... 10.00 by 17.00 cm
(3.94 by 6.69 in.)

NI 5102 (ISA) ..... 10.67 by 17.45 cm
(4.2 by 6.87 in.)

NI 5102 (USB)..... 14.6 by 21.3 by 3.8 cm
(5.8 by 8.4 by 1.5 in.)

Maximum Working Voltage

(Signal voltage plus common-mode voltage)

Channel to earth.....5 V, Installation Category I

Channel to channel .....5 V, Installation Category I

Environmental

Operating temperature .....0 to 55 °C

Storage temperature.....–20 to 70 °C

Relative humidity .....10% to 90% noncondensing

Maximum Altitude .....2000 meters

Pollution degree.....2

Indoor use only

Safety

Meets the requirements of the the following standards for safety for electrical equipment for measurement, control, and laboratory use:

EN 61010-1:1993/A2:1995, IEC 61010-1:1990/A2:1995
UL 3101-1:1993, UL 3111-1:1994, UL 3121:1998
CAN/CSA C22.2 NO. 1010.1:1992/A2:1997

Electromagnetic Compatibility

CE, C-Tick, and FCC Part 15 (Class A) Compliant

Electrical emissions .....EN 55011 Class A at 10 meters
FCC Part 15A above 1 GHz

Electrical immunity .....Evaluated to EN 61326:1997/A1:1998, Table 1

Note For full EMC compliance, you must operate this device with shielded cabling. In addition, all covers and filler panels must be installed. See the Declaration of Conformity (DoC) for this product for any additional regulatory compliance information. To obtain the DoC for this product, click **Declaration of Conformity** at `ni.com/hardref.nsf/`. This website lists the DoCs by product family. Select the appropriate product family, followed

by your product, and a link to the DoC (in Adobe Acrobat format) appears. Click the Acrobat icon to download or read the DoC.

Calibration

Internal ..... Upon software command; adjusts timing for RIS acquisitions only

Interval ..... 1 week, or anytime operating environment changes

External ..... Internal reference recalibrated

Interval ..... 1 year

Warm-up time ..... 15 minutes

B

Technical Support Resources

Web Support

NI Web support is your first stop for help in solving installation, configuration, and application problems and questions. Online problem-solving and diagnostic resources include frequently asked questions, knowledge bases, product-specific troubleshooting wizards, manuals, drivers, software updates, and more. Web support is available through the Technical Support section of `ni.com`.

NI Developer Zone

The NI Developer Zone at `ni.com/zone` is the essential resource for building measurement and automation systems. At the NI Developer Zone, you can easily access the latest example programs, system configurators, tutorials, technical news, as well as a community of developers ready to share their own techniques.

Customer Education

NI provides a number of alternatives to satisfy your training needs, from self-paced tutorials, videos, and interactive CDs to instructor-led hands-on courses at locations around the world. Visit the Customer Education section of `ni.com` for online course schedules, syllabi, training centers, and class registration.

System Integration

If you have time constraints, limited in-house technical resources, or other dilemmas, you may prefer to employ consulting or system integration services. You can rely on the expertise available through our worldwide network of Alliance Program members. To find out more about our Alliance system integration solutions, visit the System Integration section of `ni.com`.

Worldwide Support

NI has offices located around the world to help address your support needs. You can access our branch office Web sites from the Worldwide Offices section of `ni.com`. Branch office Web sites provide up-to-date contact information, support phone numbers, e-mail addresses, and current events.

If you have searched the technical support resources on our Web site and still cannot find the answers you need, contact your local office or NI corporate. Phone numbers for our worldwide offices are listed at the front of this manual.

Glossary

Prefix	Meaning	Value
p-	pico-	10^{-12}
n-	nano-	10^{-9}
µ-	micro-	10^{-6}
m-	milli-	10^{-3}
k-	kilo-	10^{3}
M-	mega-	10^{6}
G-	giga-	10^{9}

Numbers/Symbols

°	degree
–	negative of, or minus
Ω	ohm
/	per
%	percent
+	positive of, or plus
±	plus or minus
+5 V	+5 Volts signal

A

A	amperes
A/D	analog-to-digital
AC	alternating current

AC coupled	allowing the transmission of AC signals while blocking DC signals
ADC	analog-to-digital converter—an electronic device, often an integrated circuit, that converts an analog voltage to a digital number
ADC resolution	the resolution of the ADC, which is measured in bits. An ADC with 16 bits has a higher resolution, and thus a higher degree of accuracy, than a 12-bit ADC
alias	a false lower frequency component that appears in sampled data acquired at too low a sampling rate
amplification	a type of signal conditioning that improves accuracy in the resulting digitized signal and reduces noise
amplitude flatness	a measure of how close to constant the gain of a circuit remains over a range of frequencies
analog bandwidth	the frequency at which the measured amplitude is 3 dB below the actual amplitude of the signal. This amplitude loss occurs at very low frequencies if the signal is AC coupled and at very high frequencies, regardless of coupling
Analog Trigger Circuit Output	digital output of the analog trigger circuit
ANSI	American National Standards Institute
ASIC	Application-Specific Integrated Circuit—a proprietary semiconductor component designed and manufactured to perform a set of specific functions for a specific customer
attenuate	to decrease the amplitude of a signal
attenuation ratio	the factor by which a signal's amplitude is decreased

B

b	bit—one binary digit, either 0 or 1
B	byte—eight related bits of data, an eight-bit binary number. Also used to denote the amount of memory required to store one byte of data

bandwidth	the range of frequencies present in a signal, or the range of frequencies to which a measuring device can respond
bipolar	a signal range that includes both positive and negative values (for example, –5 V to +5 V)
BNC	a type of coaxial signal connector
buffer	temporary storage for acquired or generated data
burst-mode	a high-speed data transfer in which the address of the data is sent followed by back-to-back data words while a physical signal is asserted
bus	the group of conductors that interconnect individual circuitry in a computer. Typically, a bus is the expansion vehicle to which I/O or other devices are connected. Examples of PC buses are the PCI bus, AT bus, NuBus, Micro Channel, and EISA bus
bus master	a type of a plug-in board or controller with the ability to read and write devices on the computer bus

C

C	Celsius
cache	high-speed processor memory that buffers commonly used instructions or data to increase processing throughput
CalDAC	calibration DAC
calibration	the process of minimizing measurement errors by making small circuit adjustments
cascading	process of extending the counting range of a counter chip by connecting to the next higher counter
C_c	lumped cable capacitance
CH0	channel number zero
CH1	channel number one

channel	pin or wire lead to which you apply or from which you read the analog or digital signal. Analog signals can be single-ended or differential. For digital signals, you group channels to form ports. Ports usually consist of either four or eight digital channels
C_{in}	input capacitance
circuit trigger	a condition for starting or stopping clocks
clock	hardware component that controls timing for reading from or writing to groups
CMOS	complementary metal-oxide semiconductor
CMRR	common-mode rejection ratio—a measure of an instrument's ability to reject interference from a common-mode signal, usually expressed in decibels (dB)
code width	the smallest detectable change in an input voltage of a DAQ device
cold-junction compensation	a method of compensating for inaccuracies in thermocouple circuits
common-mode range	the input range over which a circuit can handle a common-mode signal
common-mode signal	the mathematical average voltage, relative to the computer's ground, of the signals from a differential input
common-mode voltage	any voltage present at the instrumentation amplifier inputs with respect to amplifier ground
compensation range	the range of a parameter for which compensating adjustment can be made
conditional retrieval	a method of triggering in which you simulate an analog trigger using software. Also called software triggering
conversion device	device that transforms a signal from one form to another. For example, analog-to-digital converters (ADCs) for analog input, digital-to-analog converters (DACs) for analog output, digital input or output ports, and counter/timers are conversion devices
conversion time	the time required, in an analog input or output system, from the moment a channel is interrogated (such as with a read instruction) to the moment that accurate data is available

counter/timer	a circuit that counts external pulses or clock pulses (timing)
coupling	the manner in which a signal is connected from one location to another
C_p	probe capacitance
CPU	central processing unit
crosstalk	an unwanted signal on one channel due to an input on a different channel
current drive capability	the amount of current a digital or analog output channel is capable of sourcing or sinking while still operating within voltage range specifications
current sinking	the ability of a DAQ device to dissipate current for analog or digital output signals
current sourcing	the ability of a DAQ device to supply current for analog or digital output signals

D

D/A	digital-to-analog
D*/A	digital-to-analog, active low
DAC	digital-to-analog converter—an electronic device, often an integrated circuit, that converts a digital number into a corresponding analog voltage or current
daisy-chain	a method of propagating signals along a bus, in which the devices are prioritized on the basis of their position on the bus
DAQ	data acquisition—(1) collecting and measuring electrical signals from sensors, transducers, and test probes or fixtures and inputting them to a computer for processing; (2) collecting and measuring the same kinds of electrical signals with A/D and/or DIO boards plugged into a computer, and possibly generating control signals with D/A and/or DIO boards in the same computer
dB	decibel—the unit for expressing a logarithmic measure of the ratio of two signal levels: dB=20log10 V1/V2, for signals in volts
DC	direct current

DC coupled	allowing the transmission of both AC and DC signals
default setting	a default parameter value recorded in the driver. In many cases, the default input of a control is a certain value (often 0) that means *use the current default setting*. For example, the default input for a parameter may be *do not change current setting*, and the default setting may be *no AMUX-64T boards*. If you do change the value of such a parameter, the new value becomes the new setting. You can set default settings for some parameters in the configuration utility or manually using switches located on the device
device	a plug-in DAQ device, card, or pad that can contain multiple channels and conversion devices. Plug-in boards, PCMCIA cards, and devices such as the DAQPad-1200, which connects to your computer parallel port, are all examples of DAQ devices. SCXI modules are distinct from devices, with the exception of the SCXI-1200, which is a hybrid
DIFF	differential mode
differential input	an analog input consisting of two terminals, both of which are isolated from computer ground, whose difference is measured
differential measurement system	a way you can configure your device to read signals, in which you do not need to connect either input to a fixed reference, such as the earth or a building ground
digital port	*see* port
digital trigger	a TTL level signal having two discrete levels—a high and a low level
DIN	Deutsche Industrie Norme
DIO	digital input/output
DIP	dual inline package
dithering	the addition of Gaussian noise to an analog input signal
DMA	direct memory access—a method by which data can be transferred to/from computer memory from/to a device or memory on the bus while the processor does something else. DMA is the fastest method of transferring data to/from computer memory
DNL	differential nonlinearity—a measure in LSB of the worst-case deviation of code widths from their ideal value of 1 LSB

DOS	disk operating system
down counter	performing frequency division on an internal signal
DRAM	dynamic RAM
drivers	software that controls a specific hardware device such as a DAQ device or a GPIB interface board
DSO	digital storage oscilloscope
dual-access memory	memory that can be sequentially accessed by more than one controller or processor but not simultaneously accessed. Also known as shared memory
dynamic range	the ratio of the largest signal level a circuit can handle to the smallest signal level it can handle (usually taken to be the noise level), normally expressed in decibels

E

EEPROM	electrically erasable programmable read-only memory—ROM that can be erased with an electrical signal and reprogrammed
EISA	extended industry standard architecture
electrostatically coupled	propagating a signal by means of a varying electric field
EMC	electromechanical compliance
encoder	a device that converts linear or rotary displacement into digital or pulse signals. The most popular type of encoder is the optical encoder, which uses a rotating disk with alternating opaque areas, a light source, and a photodetector
End of Acquisition	end of acquisition signal
EPROM	erasable programmable read-only memory—ROM that can be erased (usually by ultraviolet light exposure) and reprogrammed
ETS	equivalent time sampling

expansion ROM	an onboard EEPROM that may contain device-specific initialization and system boot functionality
external trigger	a voltage pulse from an external source that triggers an event such as A/D conversion

F

false triggering	triggering that occurs at an unintended time
FET	field-effect transistor
fetch-and-deposit	a data transfer in which the data bytes are transferred from the source to the controller, and then from the controller to the target
FIFO	first-in first-out memory buffer—the first data stored is the first data sent to the acceptor. FIFOs are often used on DAQ devices to temporarily store incoming or outgoing data until that data can be retrieved or output. For example, an analog input FIFO stores the results of A/D conversions until the data can be retrieved into system memory, a process that requires the servicing of interrupts and often the programming of the DMA controller. This process can take several milliseconds in some cases. During this time, data accumulates in the FIFO for future retrieval. With a larger FIFO, longer latencies can be tolerated. In the case of analog output, a FIFO permits faster update rates, because the waveform data can be stored on the FIFO ahead of time. This again reduces the effect of latencies associated with getting the data from system memory to the DAQ device
filtering	a type of signal conditioning that allows you to filter unwanted signals from the signal you are trying to measure
flash ADC	an ADC whose output code is determined in a single step by a bank of comparators and encoding logic
floating signal sources	signal sources with voltage signals that are not connected to an absolute reference or system ground. Also called nonreferenced signal sources. Some common example of floating signal sources are batteries, transformers, or thermocouples
ft	feet

G

gain	the factor by which a signal is amplified, sometimes expressed in decibels
gain accuracy	a measure of deviation of the gain of an amplifier from the ideal gain
GND	ground signal
grounded measurement system	*see* RSE

H

h	hour
half-flash ADC	an ADC that determines its output code by digitally combining the results of two sequentially performed, lower-resolution flash conversions
half-power bandwidth	the frequency range over which a circuit maintains a level of at least –3 dB with respect to the maximum level
hardware	the physical components of a computer system, such as the circuit boards, plug-in boards, chassis, enclosures, peripherals, cables, and so on
hex	hexadecimal
Hz	hertz—the number of scans read or updates written per second

I

I/O	input/output—the transfer of data to/from a computer system involving communications channels, operator interface devices, and/or data acquisition and control interfaces
IBM	International Business Machines
IC	integrated circuit
ID	identification
IEEE	Institute of Electrical and Electronics Engineers
in.	inches

input bias current	the current that flows into the inputs of a circuit
input impedance	the measured resistance and capacitance between the input terminal of a circuit
input offset current	the difference in the input bias currents of the two inputs of an instrumentation amplifier
instrument driver	a set of high-level software functions that controls a specific GPIB, VXI, or RS-232 programmable instrument or a specific plug-in DAQ device. Instrument drivers are available in several forms, ranging from a function callable language to a virtual instrument (VI) in LabVIEW
interrupt	a computer signal indicating that the CPU should suspend its current task to service a designated activity
interrupt level	the relative priority at which a device can interrupt
interval scanning	scanning method where there is a longer interval between scans than there is between individual channels comprising a scan
INTR*	interrupt request signal, active low
I_{OH}	current, output high
I_{OL}	current, output low
I_{OS}	output short circuit current
IRQ	interrupt request
ISA	industry standard architecture
isolation	a type of signal conditioning in which you isolate the transducer signals from the computer for safety purposes. This protects you and your computer from large voltage spikes and makes sure the measurements from the DAQ device are not affected by differences in ground potentials
isolation voltage	the voltage that an isolated circuit can normally withstand, usually specified from input to input and/or from any input to the amplifier output, or to the computer bus

K

k	kilo—the standard metric prefix for 1,000, or 10^3, used with units of measure such as volts, hertz, and meters
K	kilo—the prefix for 1,024, or 2^{10}, used with B in quantifying data or computer memory
kbytes/s	a unit for data transfer that means 1,000 or 10^3 bytes/s
kS	1,000 samples
Kword	1,024 words of memory

L

LabVIEW	laboratory virtual instrument engineering workbench
latched digital I/O	a type of digital acquisition/generation where a device or module accepts or transfers data after a digital pulse has been received. Also called handshaked digital I/O
LED	light-emitting diode
low-frequency corner	in an AC-coupled circuit, the frequency below which signals are attenuated by at least 3 dB
LSB	least significant bit

M

m	meters
M	(1) Mega, the standard metric prefix for 1 million or 10^6, when used with units of measure such as volts and hertz; (2) mega, the prefix for 1,048,576, or 2^{20}, when used with B to quantify data or computer memory
MB	megabytes of memory
Mbytes/s	a unit for data transfer that means 1 million or 10^6 bytes/s
memory buffer	*see* buffer

MFLOPS	million floating-point operations per second—the unit for expressing the computational power of a processor
MIPS	million instructions per second—the unit for expressing the speed of processor machine code instructions
MISO	Master-In-Slave-Out signal
MITE	MXI Interfaces to Everything—a custom ASIC designed by National Instruments that implements the PCI bus interface. The MITE supports bus mastering for high speed data transfers over the PCI bus
MOSI	Master-Out-Slave-In signal
MS	million samples
MSB	most significant bit
MTBF	mean time between failure
mux	multiplexer—a switching device with multiple inputs that sequentially connects each of its inputs to its output, typically at high speeds, in order to measure several signals with a single analog input channel

N

NBS	National Bureau of Standards
NI-SCOPE	NI driver software for DAQ hardware
noise	an undesirable electrical signal—Noise comes from external sources such as the AC power line, motors, generators, transformers, fluorescent lights, soldering irons, CRT displays, computers, electrical storms, welders, radio transmitters, and internal sources such as semiconductors, resistors, and capacitors. Noise corrupts signals you are trying to send or receive
nonreferenced signal sources	signal sources with voltage signals that are not connected to an absolute reference or system ground. Also called floating signal sources. Some common example of nonreferenced signal sources are batteries, transformers, or thermocouples

NRSE	nonreferenced single-ended mode—all measurements are made with respect to a common (NRSE) measurement system reference, but the voltage at this reference can vary with respect to the measurement system ground
Nyquist Sampling Theorem	a law of sampling theory stating that if a continuous bandwidth-limited signal contains no frequency components higher than half the frequency at which it is sampled, then the original signal can be recovered without distortion

O

onboard channels	channels provided by the plug-in DAQ device
onboard RAM	optional RAM usually installed into SIMM slots
operating system	base-level software that controls a computer, runs programs, interacts with users, and communicates with installed hardware or peripheral devices

P

passband	the range of frequencies that a device can properly propagate or measure
PC Card	a credit-card-sized expansion card that fits in a PCMCIA slot; often referred to as a PCMCIA card
PCI	Peripheral Component Interconnect—a high-performance expansion bus architecture originally developed by Intel to replace ISA and EISA. It is achieving widespread acceptance as a standard for PCs and workstations; it offers a theoretical maximum transfer rate of 132 Mbytes/s
PCMCIA	an expansion bus architecture that has found widespread acceptance as a *de facto* standard in notebook-size computers. It originated as a specification for add-on memory cards written by the Personal Computer Memory Card International Association
peak to peak	a measure of signal amplitude; the difference between the highest and lowest excursions of the signal
pF	picofarads
PFI	programmable function input

PGIA	programmable gain instrumentation amplifier
pipeline	a high-performance processor structure in which the completion of an instruction is broken into its elements so that several elements can be processed simultaneously from different instructions
Plug and Play devices	devices that do not require DIP switches or jumpers to configure resources on the devices—also called switchless devices
Plug and Play ISA	a specification prepared by Microsoft, Intel, and other PC-related companies that will result in PCs with plug-in boards that can be fully configured in software, without jumpers or switches on the boards
port	(1) a communications connection on a computer or a remote controller (2) a digital port, consisting of four or eight lines of digital input and/or output
postriggering	the technique used on a DAQ device to acquire a programmed number of samples after trigger conditions are met
potentiometer	an electrical device the resistance of which can be manually adjusted; used for manual adjustment of electrical circuits and as a transducer for linear or rotary position
ppm	parts per million
pretriggering	the technique used on a DAQ device to keep a continuous buffer filled with data, so that when the trigger conditions are met, the sample includes the data leading up to the trigger condition
probe compensation	adjusting the tunable probe capacitor to get a flat frequency response
protocol	the exact sequence of bits, characters, and control codes used to transfer data between computers and peripherals through a communications channel, such as the GPIB bus
pts	points
pulse trains	multiple pulses
pulsed output	a form of counter signal generation by which a pulse is outputted when a counter reaches a certain value
PXI	PCI eXtensions for Instrumentation—an open specification that builds off the CompactPCI specification by adding instrumentation-specific features

R

RAM	random-access memory
real time	a property of an event or system in which data is processed as it is acquired instead of being accumulated and processed at a later time
record length	the amount of memory dedicated to storing digitized samples for postscripting or display. In a digitizer, this limits the maximum duration of a single-shot acquisition
referenced signal sources	signal sources with voltage signals that are referenced to a system ground, such as the earth or a building ground. Also called grounded signal sources
referenced single-ended measurement system	all measurements are made with respect to a common reference measurement system or a ground. Also called a grounded measurement system
relative accuracy	a measure in LSB of the accuracy of an ADC. It includes all nonlinearity and quantization errors. It does not include offset and gain errors of the circuitry feeding the ADC
resolution	the smallest signal increment that can be detected by a measurement system. Resolution can be expressed in bits, in proportions, or in percent of full scale. For example, a system has 12-bit resolution, one part in 4,096 resolution, and 0.0244 percent of full scale
R_{in}	input resistance
RIS	random-interleaved sampling
RIS GAIN	the range of values that TDC can return; the maximum TDC value minus the minimum TDC value
RIS OFFSET	the minimum value that the TDC can return
rise time	the difference in time between the 10% and 90% points of a system's step response
rms	root mean square—a measure of signal amplitude; the square root of the average value of the square of the instantaneous signal amplitude
ROM	read-only memory

R_p	probe resistance
RSE	referenced single-ended mode—all measurements are made with respect to a common reference measurement system or a ground. Also called a grounded measurement system
RTSI bus	real-time system integration bus—the NI timing bus that connects DAQ devices directly, by means of connectors on top of the boards, for precise synchronization of functions

S

s	seconds
S	samples
S/H	sample-and-hold—a circuit that acquires and stores an analog voltage on a capacitor for a short period of time
S/s	samples per second—used to express the rate at which a DAQ device samples an analog signal
sample counter	the clock that counts the output of the channel clock, in other words, the number of samples taken. On boards with simultaneous sampling, this counter counts the output of the scan clock and hence the number of scans
sample rate	the rate at which a signal is sampled and digitized by an ADC
scan	one or more analog or digital input samples. Typically, the number of input samples in a scan is equal to the number of channels in the input group. For example, one pulse from the scan clock produces one scan which acquires one new sample from every analog input channel in the group
scan clock	the clock controlling the time interval between scans. On boards with interval scanning support (for example, the AT-MIO-16F-5), this clock gates the channel clock on and off. On boards with simultaneous sampling (for example, the EISA-A2000), this clock clocks the track-and-hold circuitry
SCANCLK	scan clock signal
scan rate	the number of scans per second. For example, a scan rate of 10 Hz means sampling each channel 10 times per second

SC_TC	scan counter terminal count signal
SCXI	Signal Conditioning eXtensions for Instrumentation—the NI product line for conditioning low-level signals within an external chassis near sensors so only high-level signals are sent to DAQ devices in the noisy PC environment
SE	single-ended—a term used to describe an analog input that is measured with respect to a common ground
self-calibrating	a property of a DAQ device that has an extremely stable onboard reference and calibrates its own A/D and D/A circuits without manual adjustments by the user
settling time	the amount of time required for a voltage to reach its final value within specified limits
shared memory	*see* dual-access memory
signal divider	performing frequency division on an external signal
SIMM	single in-line memory module
Slot0Sel	slot 0 select signal
SMB	a type of miniature coaxial signal connector
SNR	signal-to-noise ratio—the ratio of the overall rms signal level to the rms noise level, expressed in decibels
software trigger	a programmed event that triggers an event such as data acquisition
software triggering	a method of triggering in which you simulate an analog trigger using software. Also called conditional retrieval
source impedance	a parameter of signal sources that reflects current-driving ability of voltage sources (lower is better) and the voltage-driving ability of current sources (higher is better)
SPICLK	Serial Peripheral Interface Clock signal
Start Trigger	start trigger signal
STC	system timing controller

switchless device	devices that do not require dip switches or jumpers to configure resources on the devices—also called Plug and Play devices
synchronous	(1) hardware—a property of an event that is synchronized to a reference clock (2) software—a property of a function that begins an operation and returns only when the operation is complete
system noise	a measure of the amount of noise seen by an analog circuit or an ADC when the analog inputs are grounded
system RAM	RAM installed on a personal computer and used by the operating system, as contrasted with onboard RAM

T

T/H	track-and-hold—a circuit that tracks an analog voltage and holds the value on command
TC	terminal count—the highest value of a counter
TDC	time-to-digital converter
time constant	a measure of a system's response time
transfer rate	the rate, measured in bytes/s, at which data is moved from source to destination after software initialization and set up operations; the maximum rate at which the hardware can operate
TRIG	a trigger channel
trigger	any event that causes or starts some form of data capture
trigger hold-off	a signal processing technique that lets you specify a time from the trigger event to ignore additional triggers that fall within that time
TTL	transistor-transistor logic

U

unipolar	a signal range that is always positive (for example, 0 to +10 V)
update	the output equivalent of a scan. One or more analog or digital output samples. Typically, the number of output samples in an update is equal to the number of channels in the output group. For example, one pulse from the update clock produces one update that sends one new sample to every analog output channel in the group
update rate	the number of output updates per second

V

V	volts
V_{DC}	volts direct current
VDMAD	virtual DMA driver
vertical sensitivity	describes the smallest input voltage change the digitizer can capture
VI	virtual instrument—(1) a combination of hardware and/or software elements, typically used with a PC, that has the functionality of a classic stand-alone instrument (2) a LabVIEW software module (VI), which consists of a front panel user interface and a block diagram program
V_{IH}	volts, input high
V_{IL}	volts, input low
V_{in}	volts in
V_{O}	volts, output
V_{OH}	volts, output high
V_{OL}	volts, output low
$V_{pk\text{-}to\text{-}pk}$	the maximum signal voltage minus the minimum signal voltage. This reflects the maximum change in signal voltage and affects the vertical sensitivity or gain of the input amplifier
V_{ref}	reference voltage

W

W	watts
waveform	multiple voltage readings taken at a specific sampling rate
word	the standard number of bits that a processor or memory manipulates at one time. Microprocessors typically use 8-, 16-, or 32-bit words
working voltage	the highest voltage that should be applied to a product in normal use, normally well under the breakdown voltage for safety margin

Z

zero-overhead looping	the ability of a high-performance processor to repeat instructions without requiring time to branch to the beginning of the instructions
zero-wait-state memory	memory fast enough that the processor does not have to wait during any reads and writes to the memory

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